

405

COMPACT
disc
DIGITAL AUDIO

SERVICE
MANUAL

CD-84



marantz®

model CD-84

Compact Disc Digital Audio Player

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Brookvale, NSW 2100
Australia
Telex: 24121

All of the above locations are fully equipped to take care of your total service needs. Because various countries have differing configuration requirements, it is necessary that you contact the service facility in your particular country. In the event that there is no service location listed for your country, please, contact the nearest facility for the necessary assistance.

In case of difficulties, do not hesitate to contact the Technical Department at abovementioned address.

marantz®

MARANTZ MODEL CD-84 COMPACT DISC

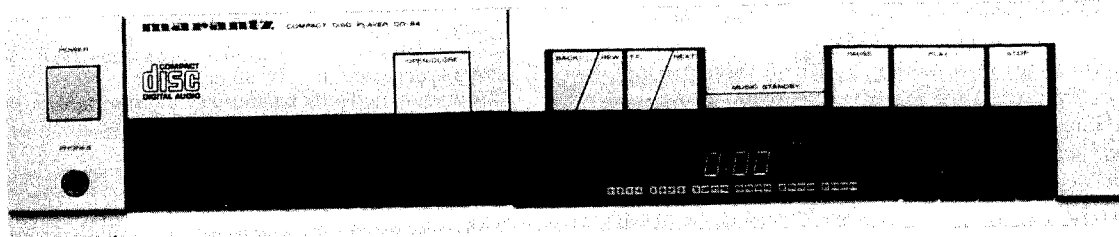


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INTRODUCTION

This service manual are prepared for use by Authorized Warranty Station and contains service information for Marantz Compact Disc.

Servicing information and voltage data included in this manual are intended for use by the knowledgeable and experienced technician only. All instructions should be read carefully. No attempt should be made to proceed without a good understanding of the operation of the Compact Disc.

The parts list furnishes information by which replacement parts may be ordered from the Marantz Company. A simple description is included for parts which can be usually obtained through local suppliers.

1. P.W. BOARDS

As can be seen from the circuit diagram, the chassis of your Compact Disc consists of the following units. Each unit mounted on a printed circuit board is described within the square enclosed by a bold dotted line on the circuit diagram.

1. Servo mounted on P.W. Board P200
2. Decoder and Headphones Amp.
. mounted on P.W. Board P500
3. Power Supply and Motor Drive
. mounted on P.W. Board P800
4. Filter mounted on P.W. Board PH00
5. Power Switch mounted on P.W. Board PS10
6. Ten Key Switch mounted on P.W. Board PS20
7. Featuer μ -com mounted on P.W. Board PT10
8. Headphone mounted on P.W. Board PU10
9. RCA Terminals mounted on P.W. Board PW10
10. Tray Open Close Sw. mounted on P.W. Board PX20
11. Front Display mounted on P.W. Board PY20
12. Sensor mounted on P.W. Board PZ20
13. Sub Chassis mounted on P.W. Board P100

MEASURING EQUIPMENT AND TEST DISC REQUIRED FOR SERVICING

- DC voltmeter
- Distortion meter
- Low pass filter
- Spectrum analyzer
- Oscilloscope
- Phase meter
- Frequency counter
- Test disc

2. FEATURES

The compact disc system is an epoch-making audio system which makes the best of state-of-the-art digital techniques.

HIGH-PERFORMANCE

The CD-84 is extremely superior in performance to the conventional analog audio systems as demonstrated by the following characteristics.

- Frequency range: 4 Hz to 20 kHz
- Dynamic range: 90 dB or greater
- Distortion factor: 0.003%
- Wow and flutter: less than measurable limit
- Channel separation: 90 dB or greater

Our unique, perfectly balanced swing mechanism provides excellent anti-vibration characteristics and immunity against oblique setting.

HIGH QUALITY SOUND

The newly developed digital filter, large-scale power transformer, audio capacitor and other high grade parts enable the conversion of all the information recorded on the disc into high quality sound.

VARIETY OF FUNCTIONS

Each audio disc contains various information other than music (e.g., selection numbers, length of each selection, etc.) and the CD-84 reads this information to provide many useful functions.

RANDOM ACCESS PROGRAMMING

Any number of selections (up to 24) can be automatically played in the desired order using the random access programming function.

DELETE PROGRAMMING

Any selections can be skipped automatically by using the delete programming function.

ALL PLAY

Of course, all selections can be played in the recorded order.

AUTO MUSIC SCAN

When the AMS (Auto Music Scan) button is pressed, the beginning of each selection recorded on the disc is automatically played for 10 seconds.

QUICK TUNE SELECTION

When the music No. is specified, play starts promptly from the beginning of the desired tune.

TUNE SELECTION WITH INDEX NO.

The CD-84 enables you to select tunes by their Index Nos.

TUNE SELECTION WITH TIME PROGRAMMING

Tune selection by specifying time is also possible.

SKIP FEATURE

By pressing the NEXT button during play you can skip selections. The number of selections skipped corresponds to the numbers of times the button is pressed and play starts from the beginning of the selected tune.

BACK SKIP FEATURE

When the BACK button is pressed once during play, the unit enters pause mode at the beginning of the current selection. When the button is pressed twice, the unit returns to the beginning of the previous selection and enters pause mode. This feature is useful for recording.

REPEAT FEATURE

Either all or selected selections can be played repeatedly.

A-B REPEAT FEATURE

When the beginning and end of the section to be played repeatedly is specified, the section can be played repeatedly.

MUSIC STANDBY FEATURE

With this feature, the unit pauses at the beginning of the specified selection. This feature is useful for recording.

3. LASER RADIATION SAFETY

Protection of eyes from laser beam during servicing
This set employs a laser. Therefore, be sure to carefully follow the instructions below when servicing.

1. Laser Diode Properties

- Material: Al Ga As
- Wave Length: 0.78 μm
- Emission Duration: Continous
- Laser Output: Max. 0.11 mW

This output is the value measured at the objective lens surface on the light pen assembly.

- Classification: Class IIIb

2. During service, do not take the subchassis block apart and do not adjust the H F amp circuit. If there is a breakdown in the H F circuit (including laser diode), replace the entire subchassis block (including H F amp circuit board).

WARNING!!

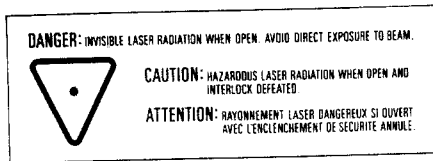
When servicing, do not approach the laser exit with the eye too closely.

In case it is necessary to confirm laser beam emission, be sure to observe from a distance of more than 30 cm from the surface of the objective lens on the light pen assembly.

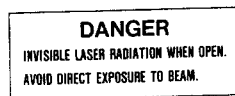
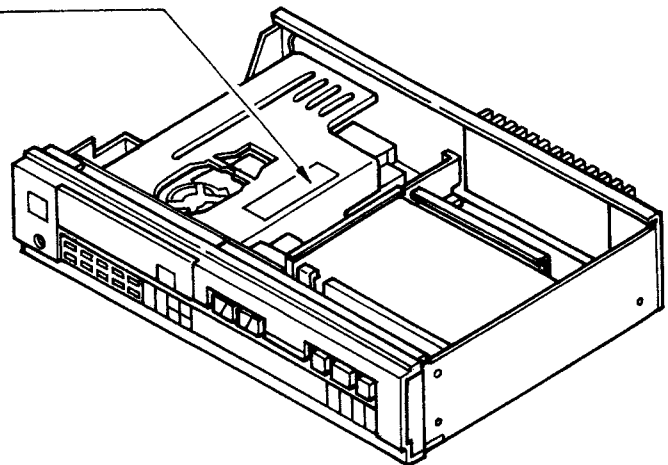
LASER WARNING LABELS

The labels shown below are affixed.

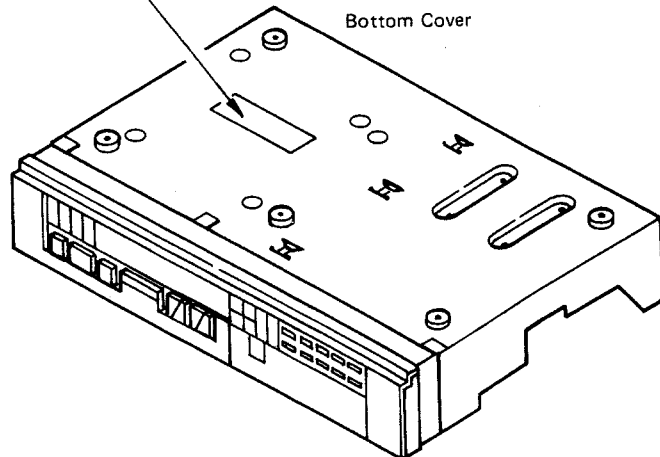
- 1) DHHS Protective housing label
"DANGER – INVISIBLE LASER RADIATION WHEN OPEN. AVOID DIRECT EXPOSURE TO BEAM."
- 2) DNHV Protective housing label and laser radiation sign label
"CAUTION – HAZARDOUS LASER RADIATION WHEN OPEN AND INTERLOCK DEFETED."
"ATTENTION – RAYONNEMENT LASER DANGER-
EUX SI OUVERT AVEC L'ENCLenchement DE
SECURITE ANNULE."



Warning Label



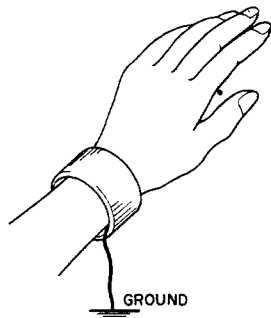
Bottom Cover



4. NOTES ON ELECTROSTATIC DAMAGE

When handling the laser diode of the optical pick-up or the MOS IC, be sure not to damage them with electrostatic. The electrostatic level charged in the human body and clothing varies with ambient conditions. However, simply walking will produce an electrostatic charge of more than several kV. With synthetic fiber clothing, an electrostatic charge of about 10 ~ 30 kV will be produced on a dry day. If the charged electrostatic voltage is applied to the electrode of the semi-conductor, the electrode may be damaged easily. When handling the laser diode or the MOS IC, pay attention to the following points.

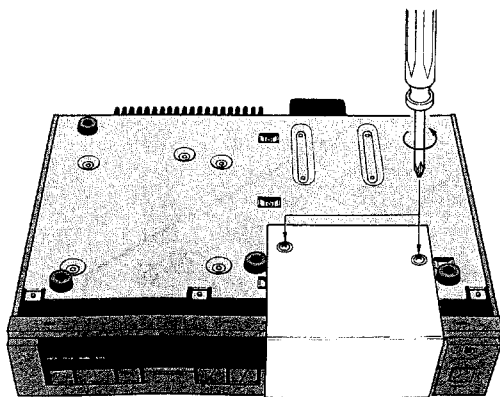
1. Lay a conductive sheet on the work bench and ground it.
2. Ground the soldering iron.
3. Do not wear synthetic fiber gloves or clothing. During operation, be sure to put on the wrist strap shown below.



4. Use a conductive material to store the semi-conductors and short-circuit the electrodes or wrap them in aluminium foil to keep the potential at each electrode the same.

5. TRANSPORTATION SCREW

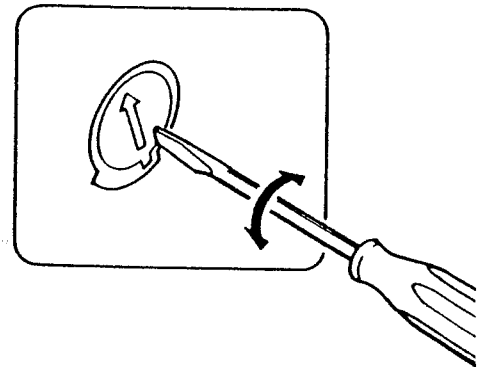
To prevent the laser pick-up from damage during transportation, the pick-up is secured with two screws. After unpacking, be sure to remove two screws. After servicing, do not forget to fix the laser pick-up with two screws.



6. VOLTAGE CONVERSION

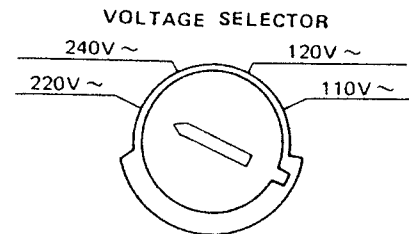
• EUROPEAN MODEL ONLY

To convert the unit to a different power source voltage, change the position as illustrated in the drawing below.



CAUTION:

DISCONNECT POWER SUPPLY CORD FROM AC OUTLET BEFORE CONVERTING VOLTAGE. DO NOT DISASSEMBLE THE VOLTAGE SELECTOR ABSOLUTELY.



NOTE ON SAFETY:

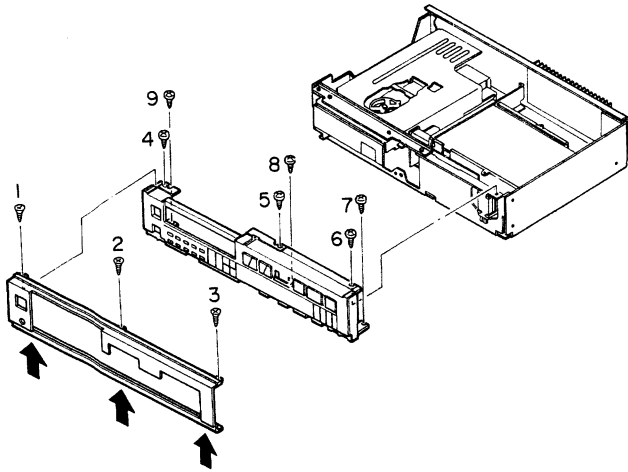
SYMBOL \triangle FIRE OR ELECTRICAL SHOCK HAZARD. ONLY ORIGINAL PARTS SHOULD BE USED TO REPLACE ANY PART MARKED WITH SYMBOL \triangle . ANY OTHER COMPONENT SUBSTITUTION (OTHER THAN ORIGINAL TYPE), MAY INCREASE RISK OF FIRE OR ELECTRICAL SHOCK HAZARD.

7. HOW TO DISASSEMBLE

7-1. HOW TO REMOVE THE FRONT PANEL AND FRONT CHASSIS

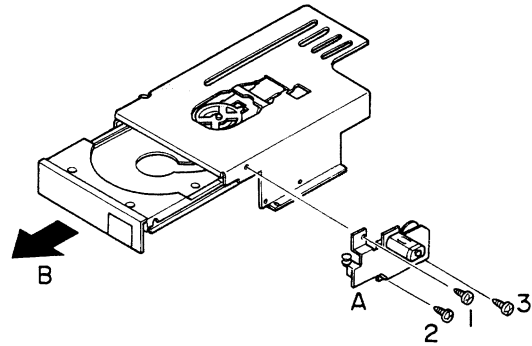
Remove screws ①~③, disengage claws indicated with arrows and remove the front panel.

Remove screws ④~⑨ and remove the front chassis.



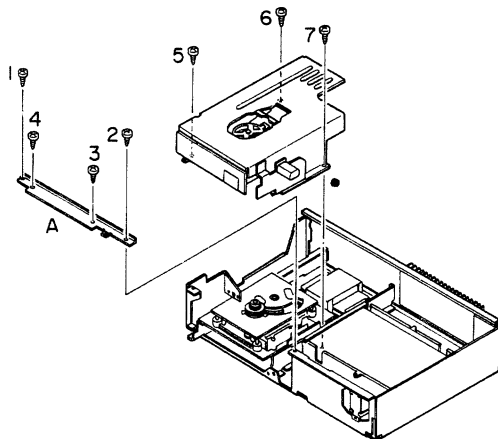
7-3. HOW TO REMOVE THE TRAY DRIVE MECHANISM

Remove screws ①~③ from the motor chassis and take out the tray in the direction of arrow B.



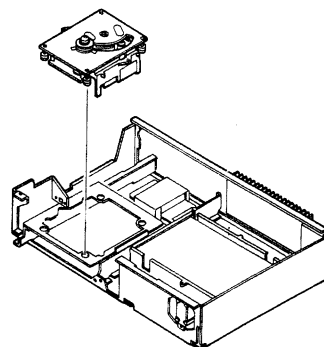
7-2. HOW TO REMOVE THE DISC TRAY

Remove screws ①~④, remove bracket A, remove screws ⑤~⑦ and remove the disc tray chassis.



7-4. HOW TO REMOVE THE SUB CHASSIS

Take out the sub chassis upward.

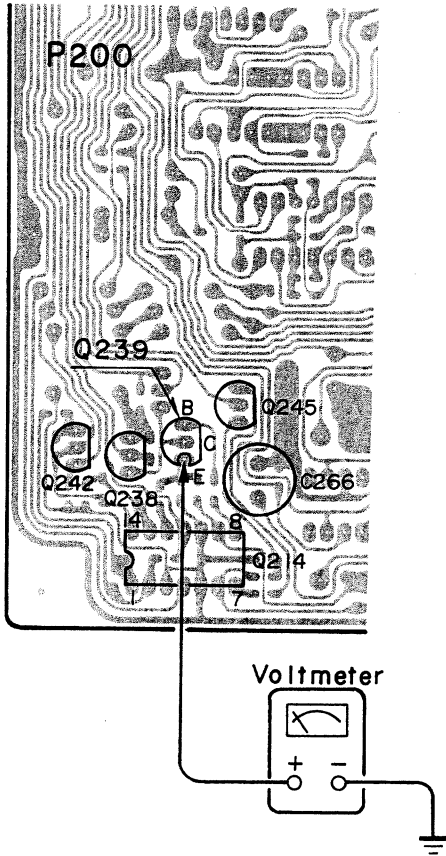


8. ADJUSTMENT AND MEASUREMENT

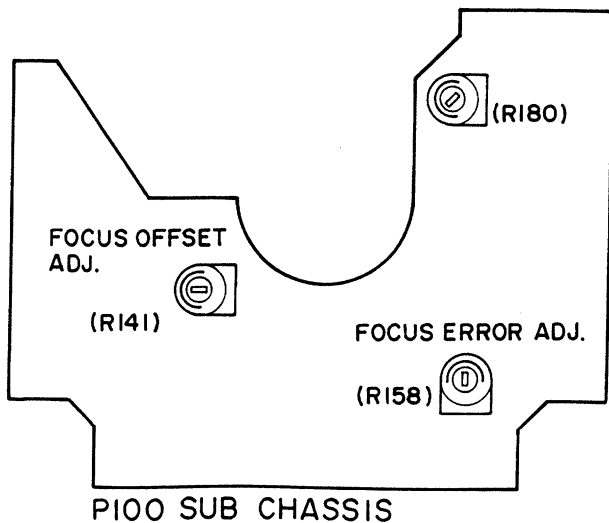
8-1. SUB CHASSIS ADJUSTMENT

8-1-1. Laser Output Adjustment

- (1) Play track 1 of the test disc (410055-2).
- (2) Connect a DC voltmeter between the emitter of Q239 and the ground of servo P.W. BOARD (P200).



- (3) Adjust R180 so the DC voltmeter reads 500 mV \pm 30 mV.

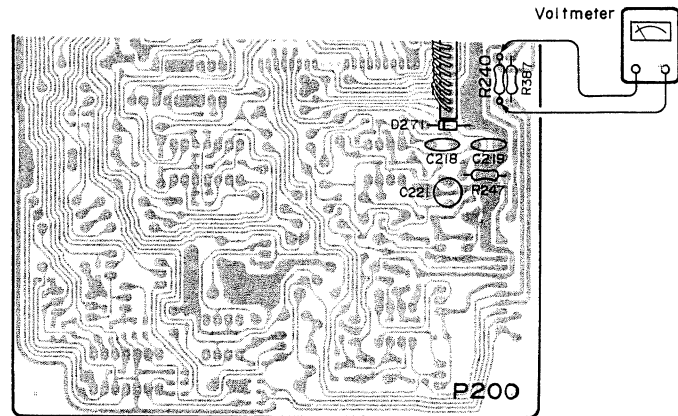


NOTE: If the test disc is not available, play the first track of a commercially available music disc.

8-1-2. Turntable Height Adjustment

To adjust the sub chassis objective lens movable range, proceed as follows.

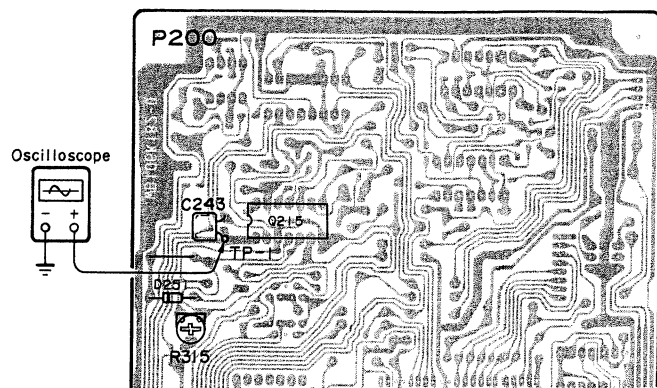
- (1) Play track 1 of the test disc (410055-2).
- (2) Connect the DC voltmeter to the ends of R240 of servo P.W. BOARD (P200)
- (3) The DC voltmeter should read 0 V \pm 100 mV. If not, adjust the turntable height as follows.
- (4) Turn the adjusting screw located at the bottom of the turntable motor so the voltage at the ends of R240 is 0 V.
- (5) After adjustment, play the outer part of the disc and check the voltage at the ends of R240 is within \pm 100 mV of that at the inner part.
- (6) After completion of adjustment, secure the screw with screw locking compound.



8-2. SERVO P.W. BOARD ADJUSTMENT

8-2-1. Radial DC Off-set Adjustment

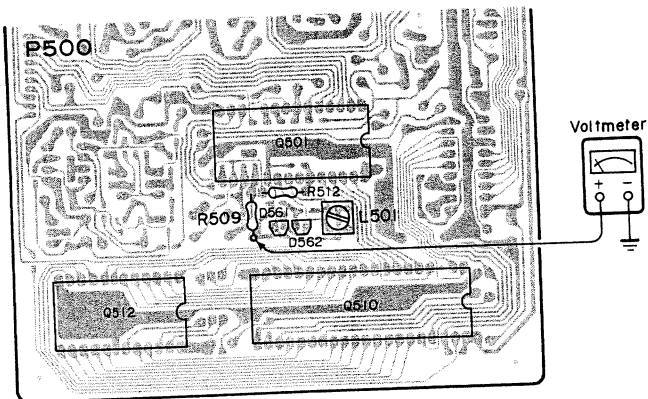
- (1) Play track 1 of the test disc (410055-2).
- (2) Connect an oscilloscope between the C243 and the ground of the servo P.W. BOARD (P200).
- (3) Adjust R315 so that the oscilloscope reads 0 V \pm 0.5 V.



8-3. DECODER P.W. BOARD ADJUSTMENT

8-3-1. PLL Circuit Adjustment

- (1) Play track 1 of the test disc (410055-2).
- (2) Connect a voltmeter between the cross point of R509 and R510 and the ground of the decoder P.W. BOARD (P500).
- (3) Adjust L501 so the voltmeter reads $5\text{ V} \pm 100\text{ mV}$.



8-4. ELECTRICAL CHARACTERISTICS MEASUREMENT

8-4-1. Frequency Response

- (1) Play track 19 of the test disc (410055-2) and set the level to 0. The frequency of track 19 is 3,150 Hz.
- (2) Play the L channel of track 4 and R channel of track 8 of the test disc (410055-2) and measure the level deviation against that of track 19 (3,150 Hz) in dB. The frequencies of tracks 4 and 8 are as follows: 41 Hz, 101 Hz, 997 Hz, 3,163 Hz, 6,363 Hz, 10,007 Hz, 16,001 Hz, 19,001 Hz, 19,997 Hz.

8-4-2. Output Level and Channel Balance

- (1) Play track 19 of the test disc (410055-2) and read the level. Calculate the level difference between the right and left channels and the result should be the channel balance.

8-4-3. Distortion and Noise

- (1) Play track 4 of the test disc (410055-2) and measure the distortion. The measuring frequencies are as follows: 41 Hz, 101 Hz, 997 Hz, 3,163 Hz, 6,363 Hz, 10,007 Hz, 16,001 Hz, 19,001 Hz, 19,997 Hz.
- (2) Perform same procedures for track 8 of the test disc (410055-2).

8-4-4. Signal-to-noise Ratio (Dynamic Range)

- (1) Play track 5 of the test disc (410055-2), measure the distortion in dB and assume it as A. The measuring frequencies are as follows: 41 Hz, 101 Hz, 997 Hz, 3,163 Hz, 6,363 Hz, 10,007 Hz, 16,001 Hz, 19,001 Hz, 19,997 Hz.
- (2) Obtain the signal-to-noise ratio and dynamic range according to the following formula.
Signal-to-noise ratio, dynamic range = $A + 24\text{ dB}$.
- (3) Perform same procedures for track 9 of the test disc (410055-2).

8-4-5. Channel Crosstalk Measurement

- (1) Play track 4 of the test disc and set the left channel output to 0.
- (2) Measure the non-signal level of the right channel and read the non-signal level difference against 0 dB in dB.
- (3) The measuring frequencies are as follows: 41 Hz, 101 Hz, 997 Hz, 3,163 Hz, 6,363 Hz, 10,007 Hz, 16,001 Hz, 19,001 Hz, 19,997 Hz.
- (4) Perform same procedures for track 8 of the test disc (410055-2).

9. DESCRIPTION OF CIRCUIT

9-1. PREAMPLIFIER IC μ PC1373H (QZ01)

The IC is a receive-only preamplifier in the infrared-ray remote-control system. High-gain amplifier, peak detector

and output shaping circuits required for a receiving pre-amplifier are built in one chip.

- Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Limit	Unit
Supply voltage	$V_{DD} - V_{SS}$	15.0	V
Power dissipation	P_d	270	mW
Operating temperature	T_{opt}	$-20 \sim +75$	$^\circ\text{C}$
Retention temperature	T_{stg}	$-40 \sim +125$	$^\circ\text{C}$

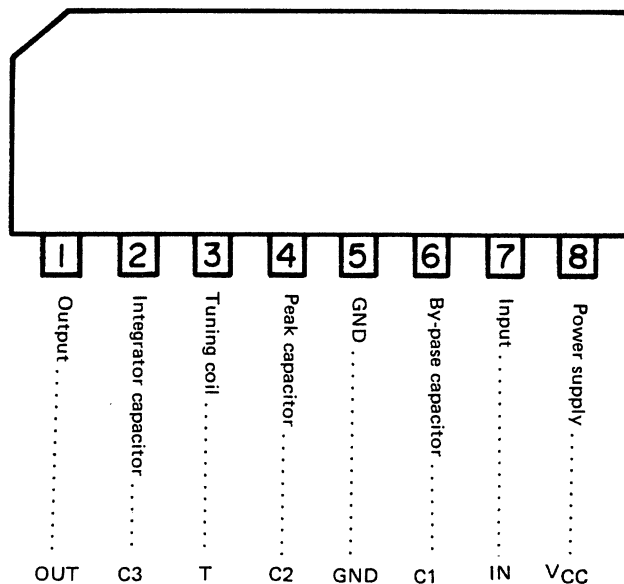
- Recommended Operating Conditions

Item	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V_{DD}	6.0	8.5	14.4	V
Frequency	f_{OSC}	30		50	kHz

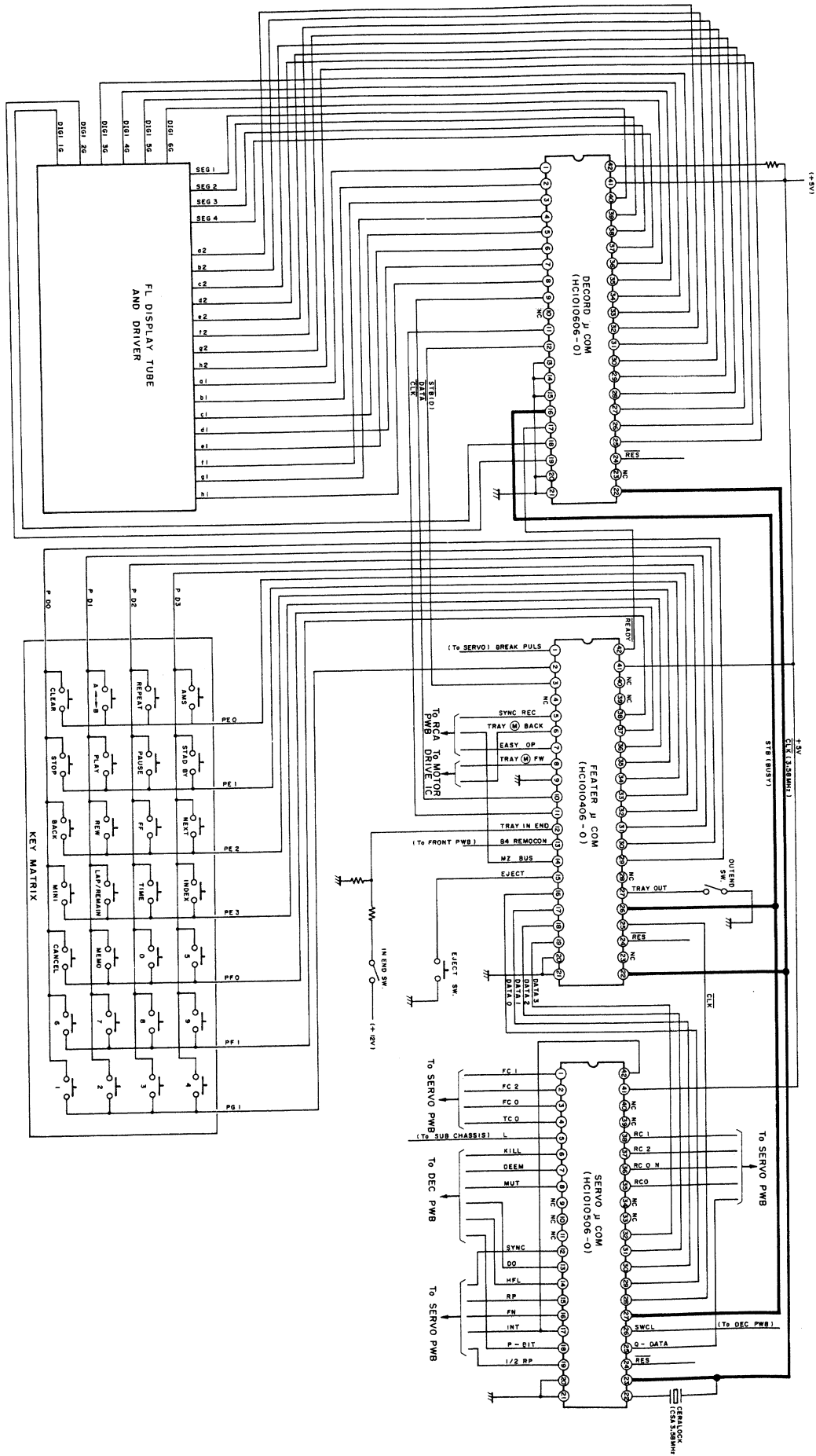
- Electrical Characteristics ($T_a = 25^\circ\text{C}$, $V_{CC} = 8.5\text{V}$, $f_{in} = 40\text{kHz}$)

Item	Symbol	Measuring Condition	Min.	Typ.	Max.	Unit
Supply current	I_{CC}		1.5	2.5	3.5	mA
Input terminal voltage	V_{in1}		2.1	2.6	3.1	V
Input terminal voltage	V_{in2}	$I_{in} = 70 \mu\text{A}$	3.4	4.1	4.9	V
First stage voltage gain	A_{vL}	#7 - #3, $v_{out} = 500 \text{ mVp-p}$		60		dB
Detecting sensitivity	v_{in}			50	100	μV
Internal input resistance	r_{in}		40	60	80	$\text{k}\Omega$
Output voltage	V_{OL}	$I_{OL} = 0.1 \text{ mA}$, $v_{in} = 1 \text{ mVp-p}$			0.5	V
Output leak current	I_{OH}	$V_{OH} = 14.4\text{V}$			2	μA

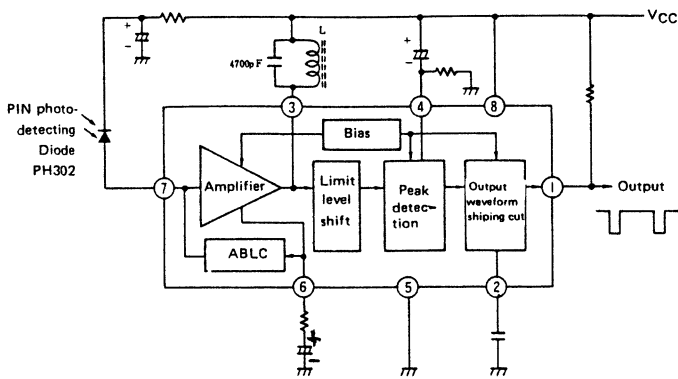
- Connection Diagram



● 3- μ -COM AND KEY MATRIX CONNECTING CKT

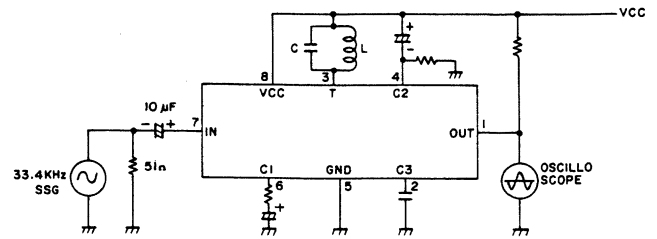


● Example of Basic Circuit



NOTE:

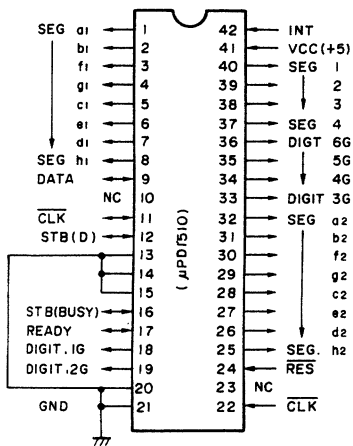
If the remote controller sensitivity cannot be adjusted or the coil (LZ01) setting is shifted, adjust LZ01 as shown below.



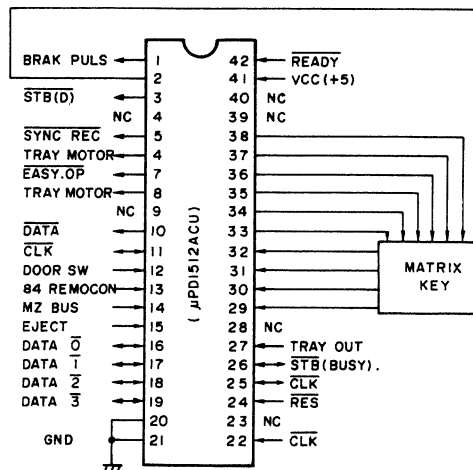
Supply a signal of 33.4 kHz from the SSG to pin (7) and adjust LZ01 so that the waveform at pin (3) becomes maximum.

9-2. µ-COM OPERATION

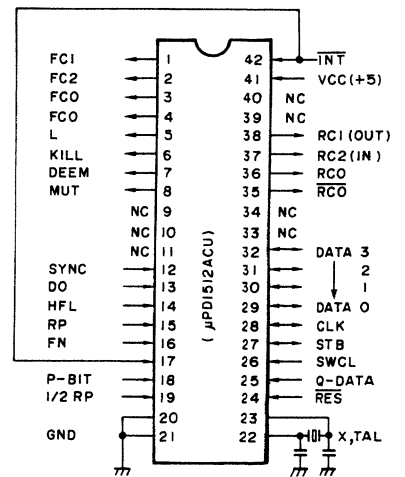
DECORDER U-COM (QY01)



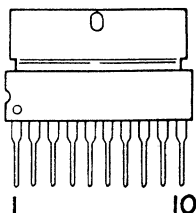
FEATUER U-COM (QT01)



SERVO U-COM (Q201)

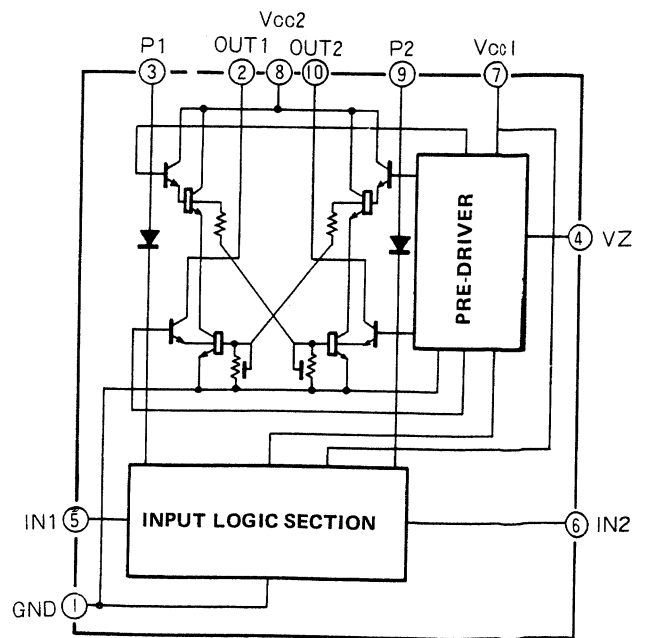


9-3. TRAY MOTOR DRIVE IC LB1645N (QM02)

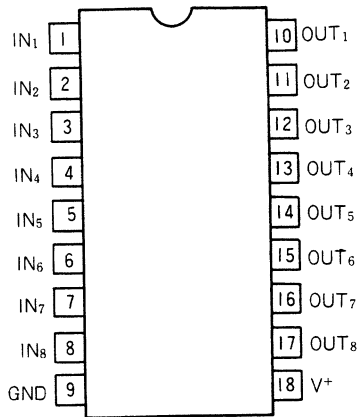


- 1. GND
- 2. OUT1
- 3. P1
- 4. VZ
- 5. IN1
- 6. IN2
- 7. Vcc1
- 8. Vcc2
- 9. P2
- 10. OUT2

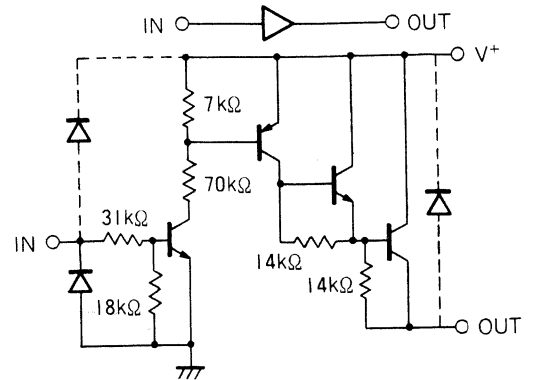
● Equivalent Circuit Block Diagram



9-4. DISPLAY DRIVER MSL918RS (QY02~QY04)

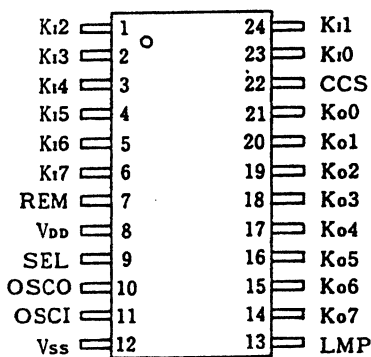


• Equivalent Schematic Diagram



9-5. C-MOS LSI μ PD6102G (QT55) FOR REMOTE CONTROL

• Pin Connection (Top View)



- | | |
|---------------------------------|---------------------------------------|
| 1. Ki2.....Key Input 2 | 13. LMPLamp Output |
| 2. Ki3.....Key Input 3 | 14. Ko7.....Key Output 7 |
| 3. Ki4.....Key Input 4 | 15. Ko6.....Key Output 6 |
| 4. Ki5.....Key Input 5 | 16. Ko5.....Key Output 5 |
| 5. Ki6.....Key Input 6 | 17. Ko4.....Key Output 4 |
| 6. Ki7.....Key Input 7 | 18. Ko3.....Key Output 3 |
| 7. REMRemote Output | 19. Ko2.....Key Output 2 |
| 8. VDDPower Terminal | 20. Ko1.....Key Output 1 |
| 9. SEL.....64/128 Date Select | 21. Ko0.....Key Output 0 |
| 10. OSCOOscillator Output | 22. CCSCustom Code Select Input |
| 11. OSCIOscillator Input | 23. Ki0.....Key Input 0 |
| 12. VSS | 24. Ki1.....Key Input 1 |

• Absolute Max. Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Limite	Unit
Supply voltage	$V_{DD} - V_{SS}$	4.0	V
Input voltage	$V_{IN} - V_{SS}$	$-0.3 \sim V_{DD}$	V
Output voltage	I_{OH} (REM, LMP)	-15.0	mA
Power dissipation	P_d	250	mW
Operating temperature	T_{opt}	$-20 \sim +75$	$^\circ\text{C}$
Retention temperature	T_{stg}	$-40 \sim +125$	$^\circ\text{C}$

• Recommended Operating Range

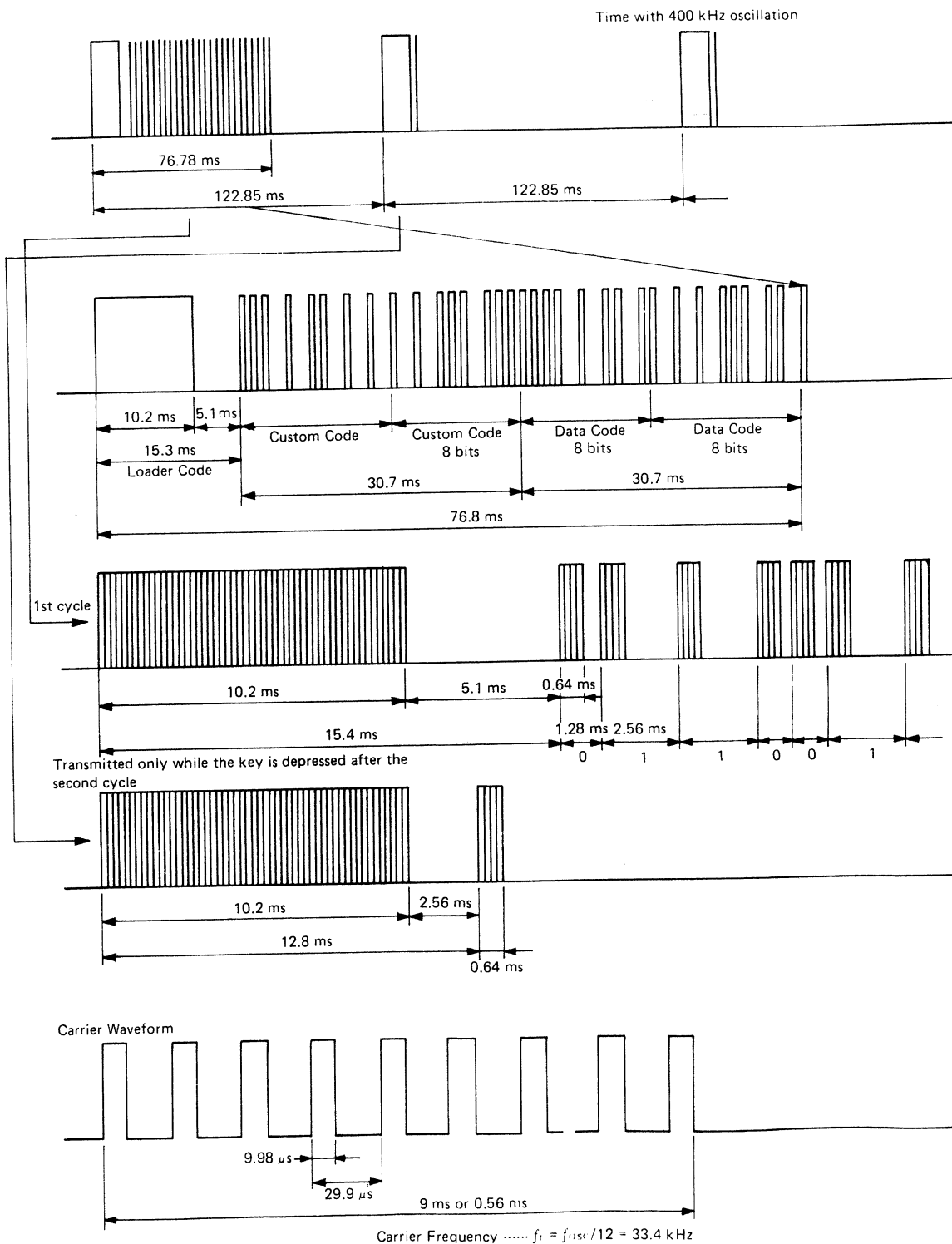
Item	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V_{DD}	2.0	3.0	3.3	V
Oscillation frequency	f_{OSC}	400	455	500	kHz
Indicator lamp output current	I_{OL} (LMP)		1		mA

• Electrical Characteristics ($T_a = 25^\circ\text{C}$, $V_{DD} = 3.0\text{V}$)

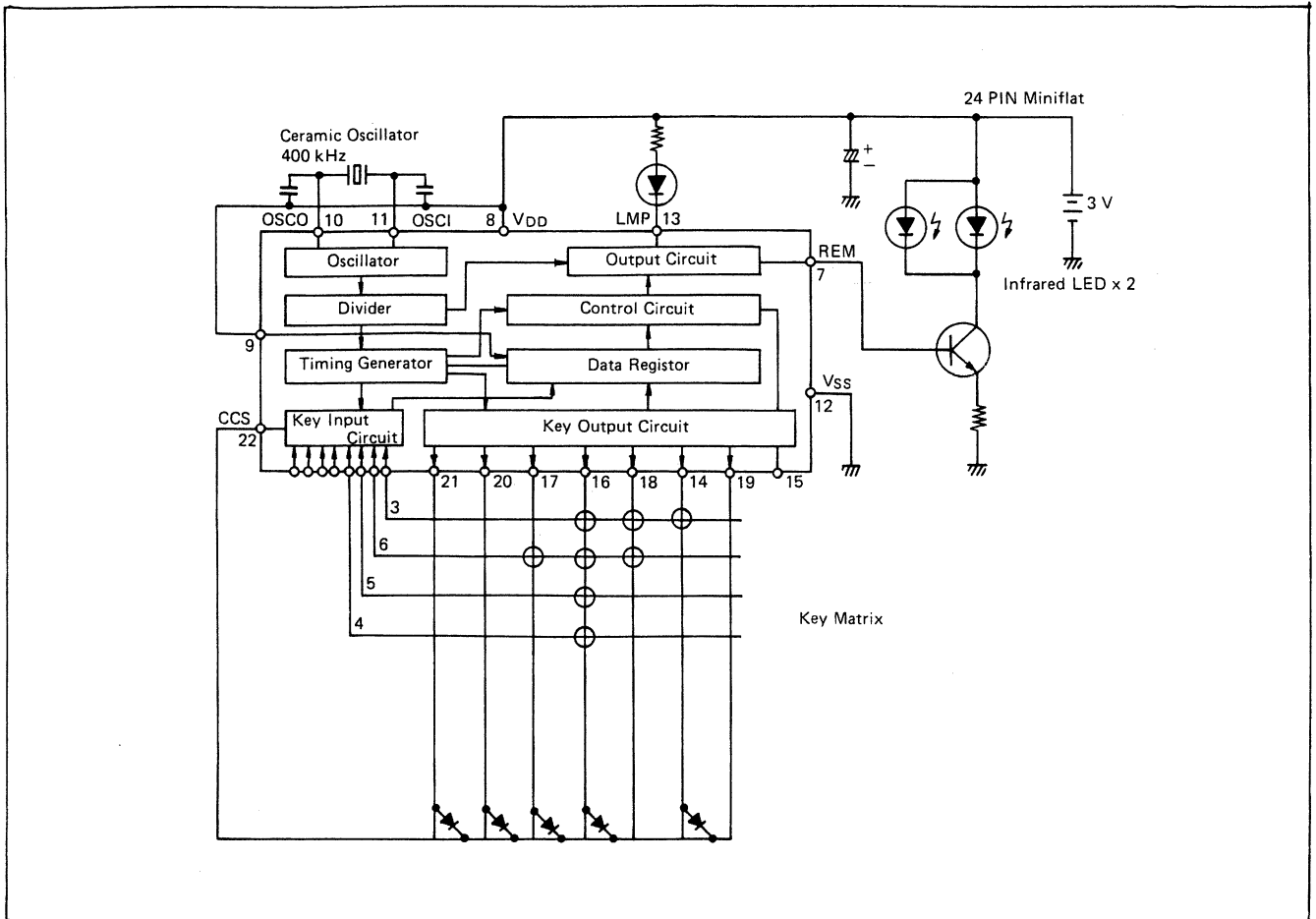
Item	Symbol	Measuring Condition	Min.	Typ.	Max.	Unit
Supply current	I_{DD} (OP)	$f_{OSC} = 455\text{ kHz}$		0.1	1.0	mA
Supply current	I_{DD} (ST)	$f_{OSC} = \text{STOP}$			1	μA
High-level input voltage	V_{IH} (KI)		$0.7V_{DD}$		V_{DD}	V
Low-level input voltage	V_{IL} (KI)		0		$0.3V_{DD}$	V
Input pull-down resistance	R (KI)		150	300	600	$\text{k}\Omega$
Output voltage	I_{OH} (REM)	V_{OH} (REM) = 1.5V	-5	-13		mA
Low-level output voltage	V_{OL} (LMP)	$I_{OL} = 1.0\text{ mA}$		0.17	0.3	V

- The pulse position modulation system (PPM) is introduced as shown in Figure for remote-control infrared ray output waveforms to discriminate 1 from 0 with a duration between pulses. Each of custom codes and data codes consists of 8 bits. Inverted codes are also transmitted in the system to minimize misoperation.

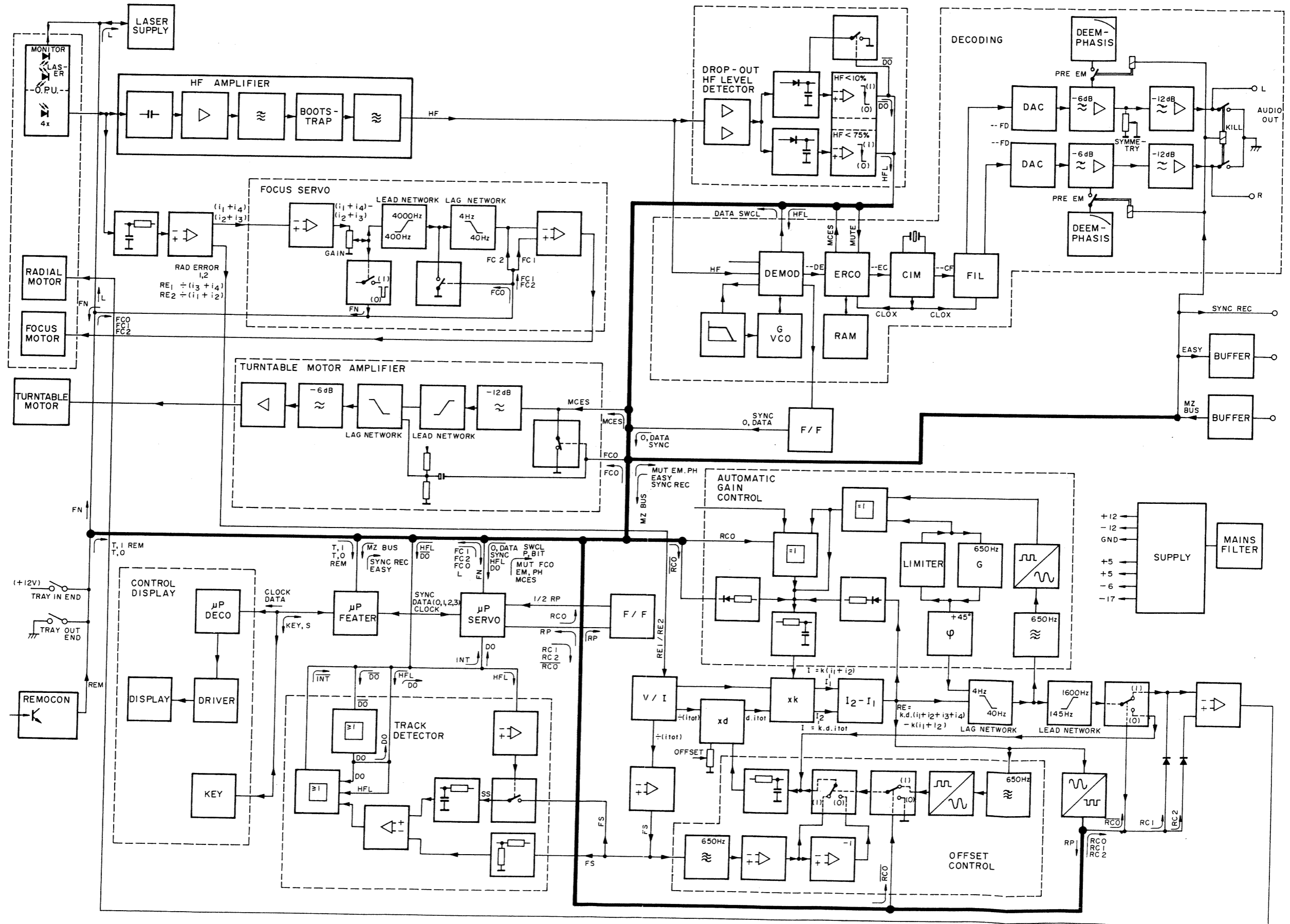
- **Remote Output Waveform**



9-6. REMOTE CONTROLLER BLOCK DIAGRAM

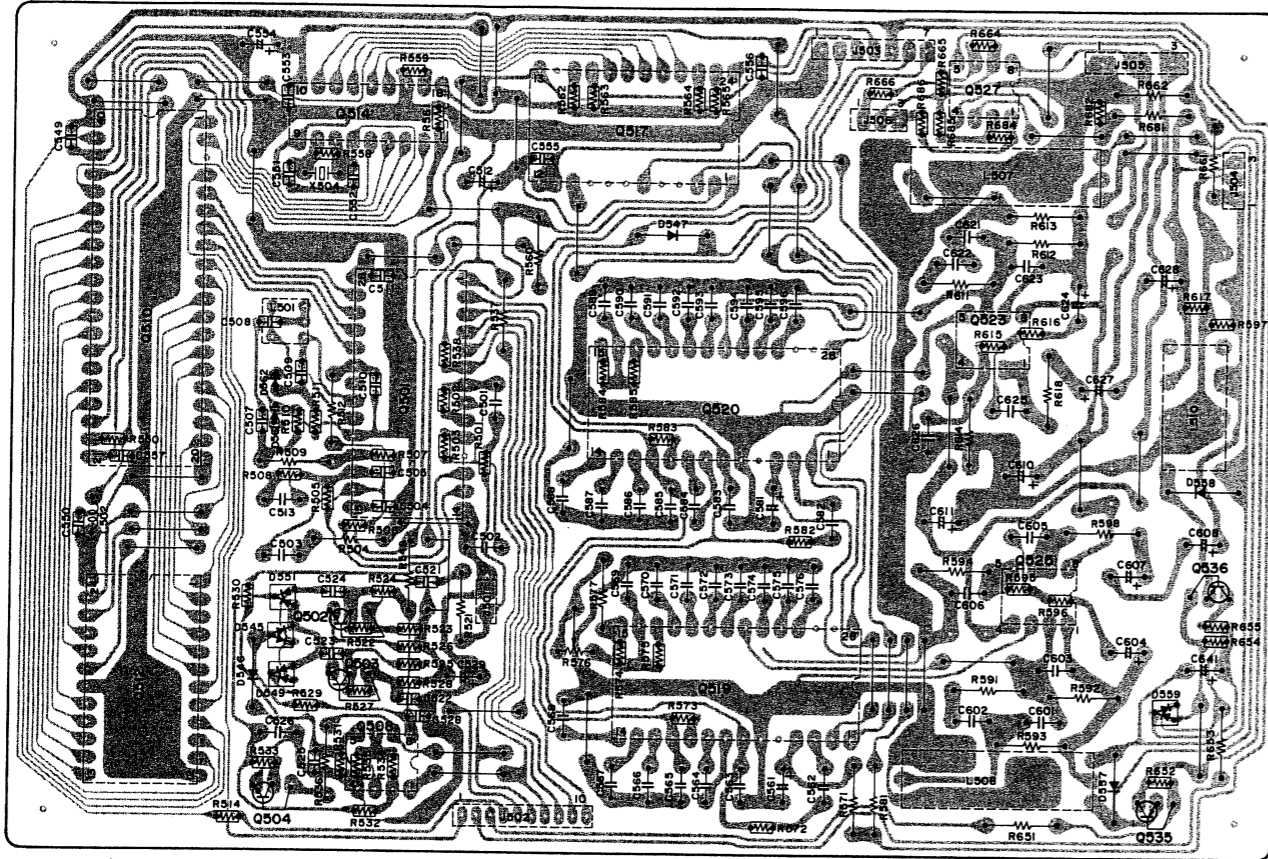


10. BLOCK DIAGRAM

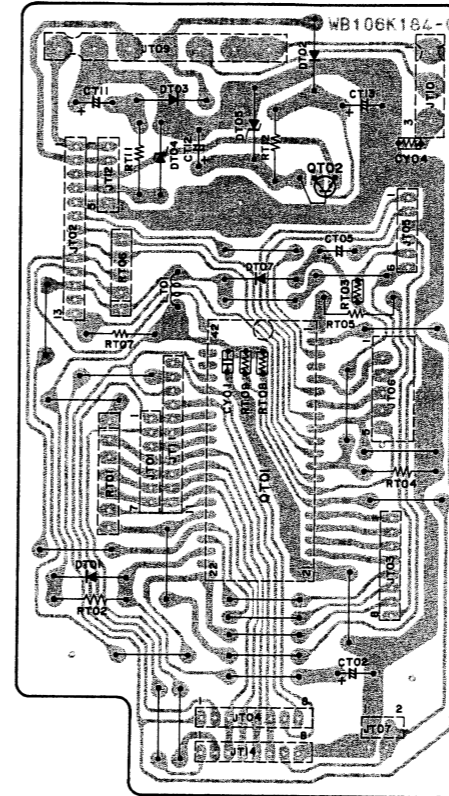


12. P.W. BOARD DIAGRAM

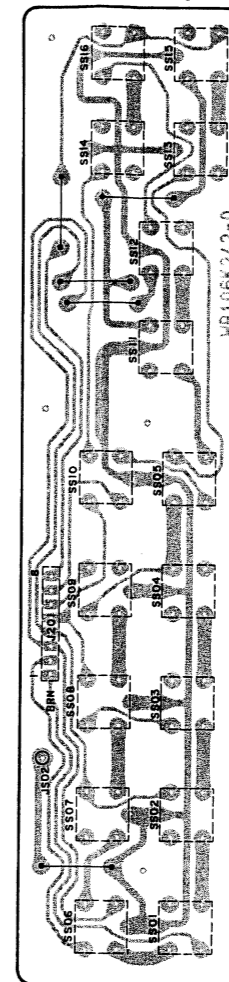
(P500) Decoder/Headphone Amp.



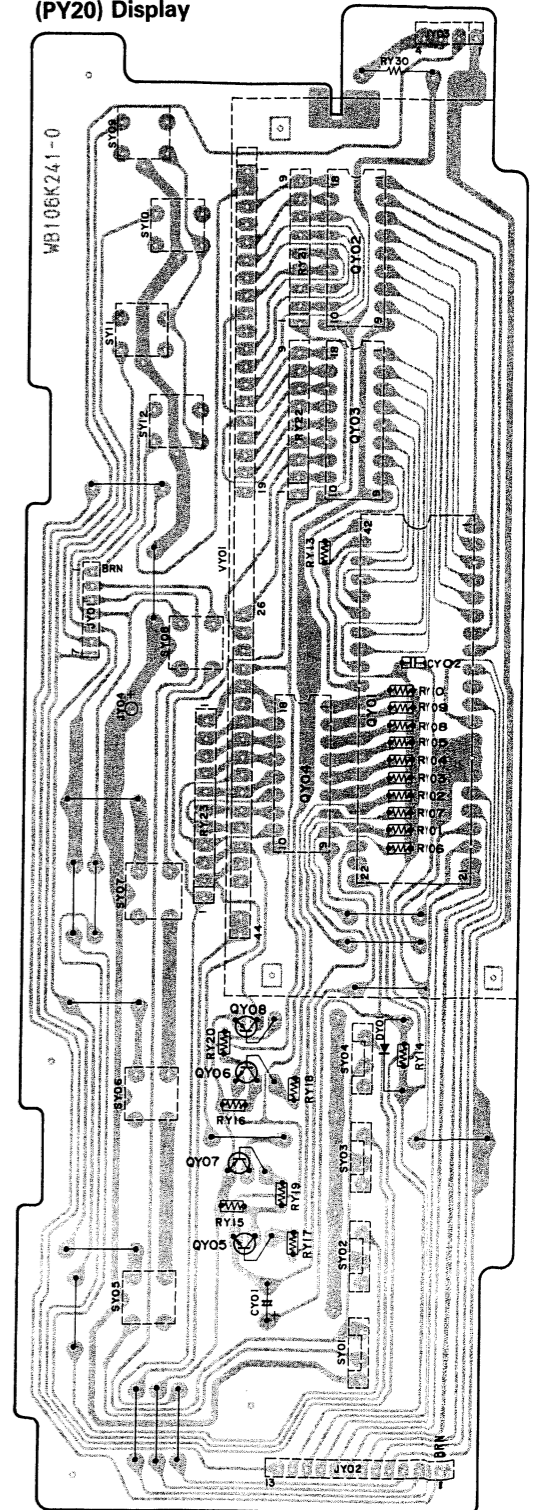
(PT10) Feater μ -com



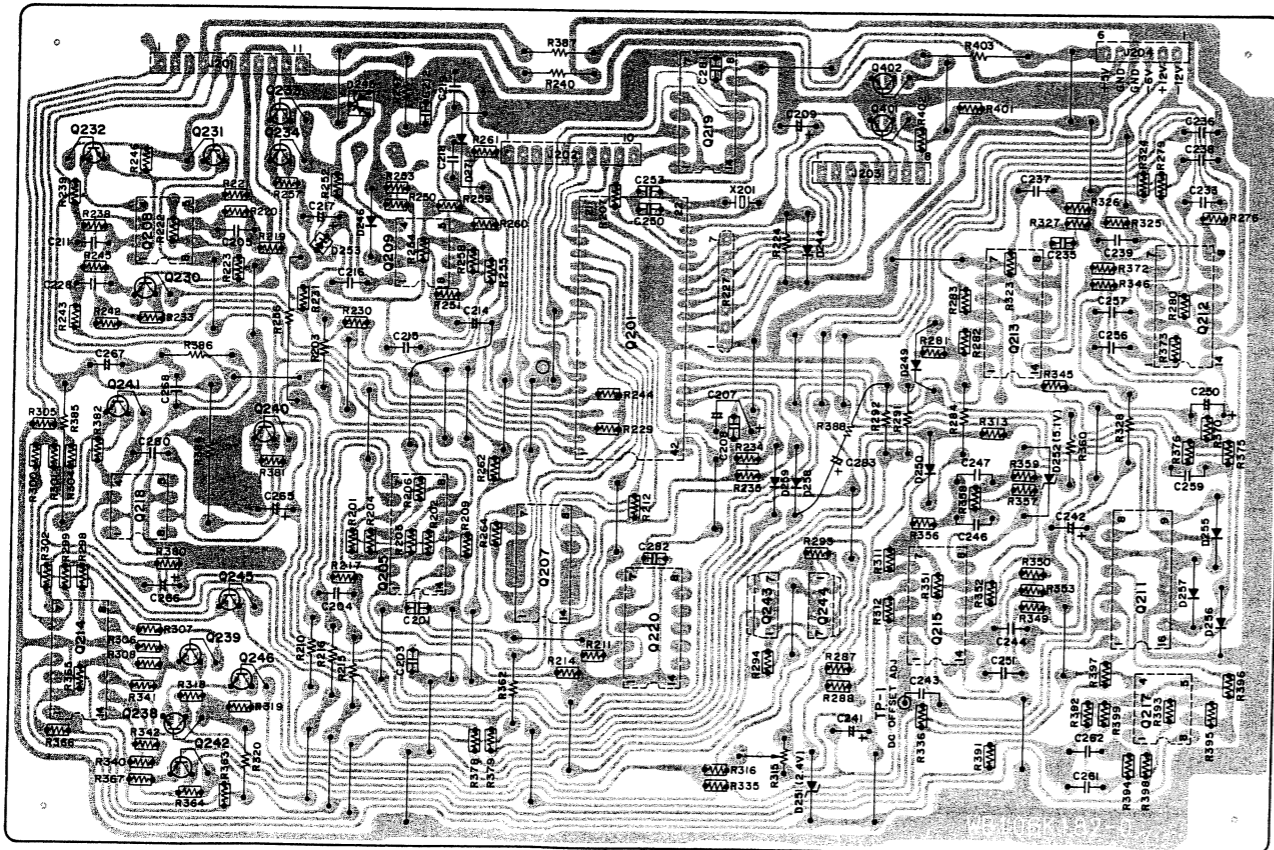
(PS20) Ten Key



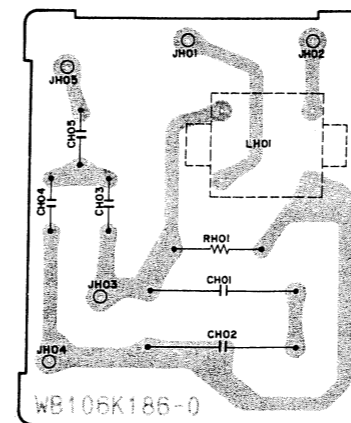
(PY20) Display



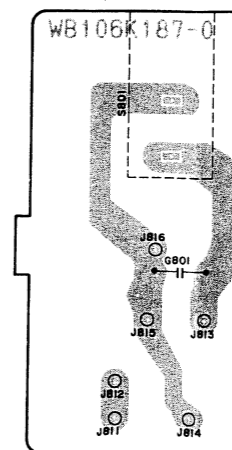
(P200) Servo



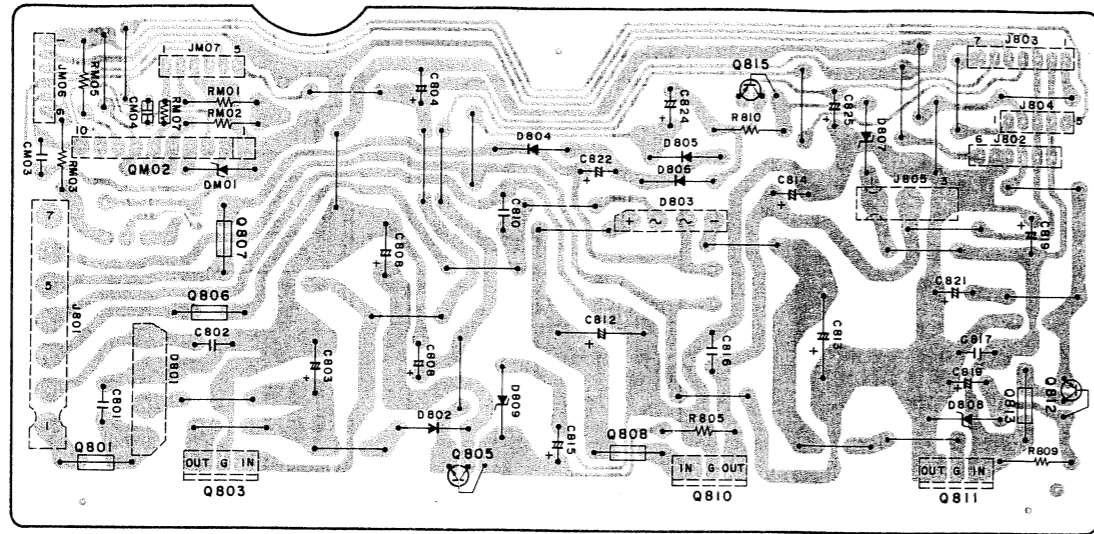
(PH00) Filter



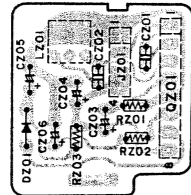
(PS10) Power Switch



(P800) Power Supply



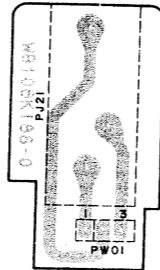
(PZ20) Sensor



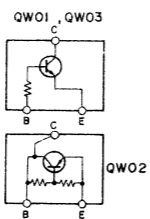
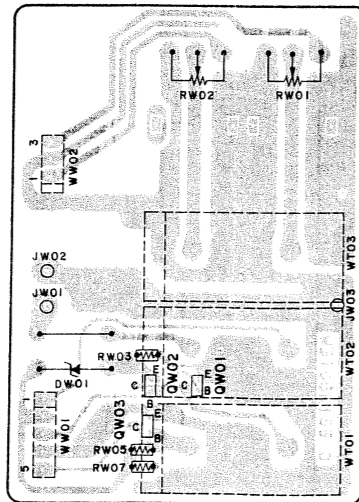
(PX20) In/Out



(PU10) Headphone Jack



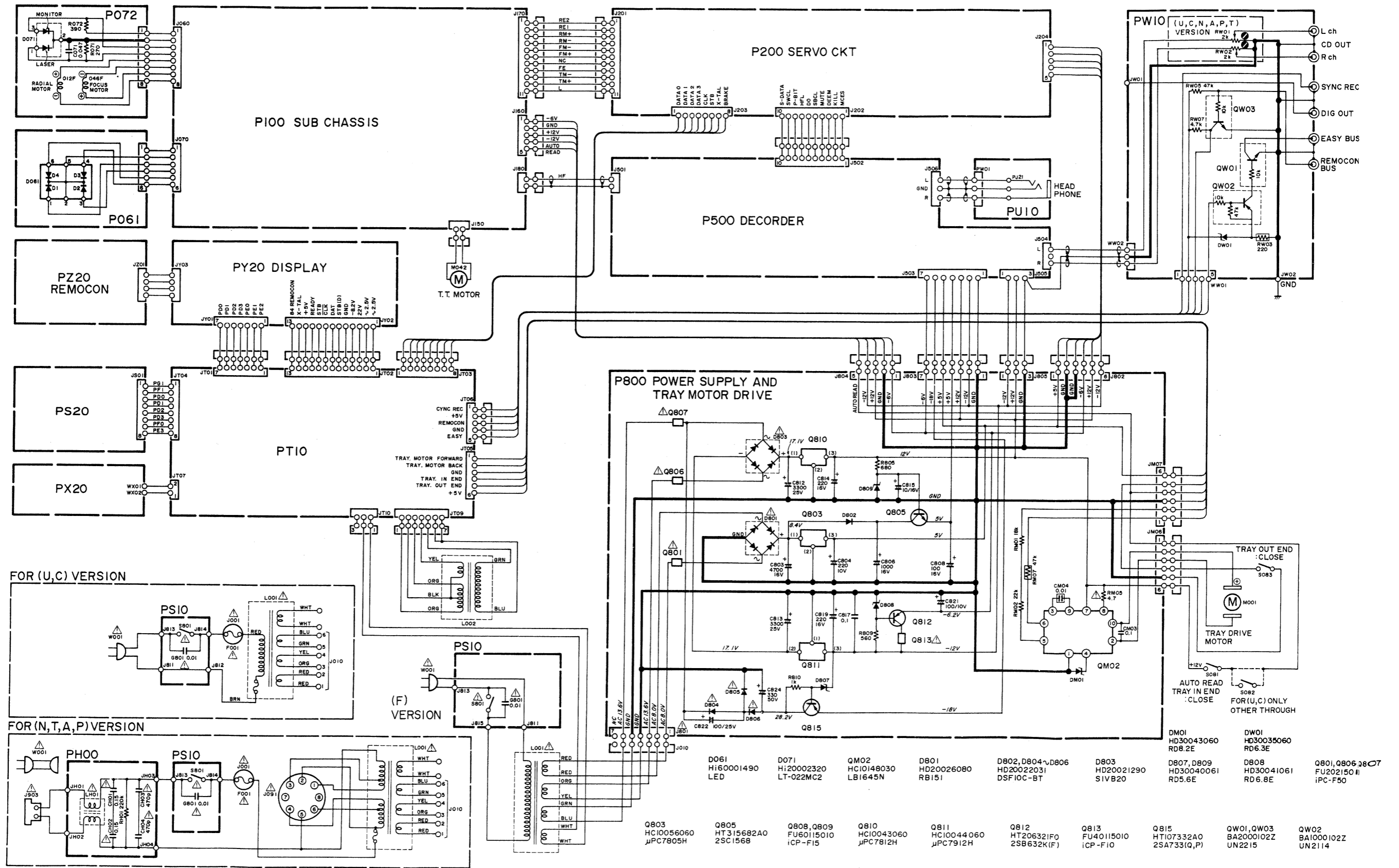
(PW10) RCA Output Pin



13. SEMICONDUCTORS ELECTRODES

	<p>2SC945(ParO) (HT30945280)</p>	<p>2SA7331(ParO) (HT107332A0)</p>	FRONT VIEW		L81645N (HC10148030)	
	<p>2SC1383(R,S) (HT313832C0)</p>	<p>2SA684(R) (HT106841R0)</p>	SIDE VIEW		µPC1373H (HC10071060)	
	<p>2SC2824(Y) (HT328241Y0)</p>	<p>2SA1184(Y) (HT111841Y0)</p>		TOP VIEW		µPC324C (HC10082060)
	<p>2SB632K(F) (HT206321F0)</p>	<p>2SC1568 (HT315682A0)</p>		TOP VIEW		HD14070B (HC10057010) HD74LS74A (HC10058010)
			IN PUT GND OUT PUT	TOP VIEW		µPC7805H (HC10056060) µPC7812H (HC10043060)
			IN PUT GND OUT PUT	TOP VIEW		µPC7912H (HC10044060)
	<p>MA151WK (HZ2000102Z)</p>	<p>MA151WA (HZ20002020)</p>		TOP VIEW		SAA7011 (HC10022270)
				TOP VIEW		SAA7020 (HC10023270)
				TOP VIEW		SAA7030 (HC10024270)
				TOP VIEW		UN2114 PNP (BA1000102Z)
				TOP VIEW		UN2215 NPN (BA2000102Z)
TOP VIEW				TOP VIEW		µPC339C (HC10081060) µPC741C (HC10083060) µPC393C (HC10084060)
TOP VIEW				TOP VIEW		NJM2904D (HC10030090) NJM4558D (HC10003090) JRC4560DD (HC10021090)
				TOP VIEW		2SC3381 G.R. (HT333811G0)
	<p>2SC2785(J or H) (HT327852A1)</p>	<p>2SA1175(RF, JF) (HT111752A1)</p>		TOP VIEW		HD14025B (HC10055010)
TOP VIEW				TOP VIEW		µPD1510AC (HC10106060)
				TOP VIEW		MSL918RS (HC10004260)

14. SCHEMATIC DIAGRAM



D244, D246, D249
D250, D255~D259
HD20001001
IS2473, IS1555
DS448, MA150

D245
HZ2000102Z
MA151WK

D251
HD30041010
HZ2C2

D252
HD30021061
RD5.1EB2

D253
HZ3000102Z
MA3068M

Q201
HC10105060
μCOM SERVO

Q205
HC10081060
μPC339C

Q207
HC10055010
HDI4025B

Q208, Q209, Q217
HC10003090
NJM4558D

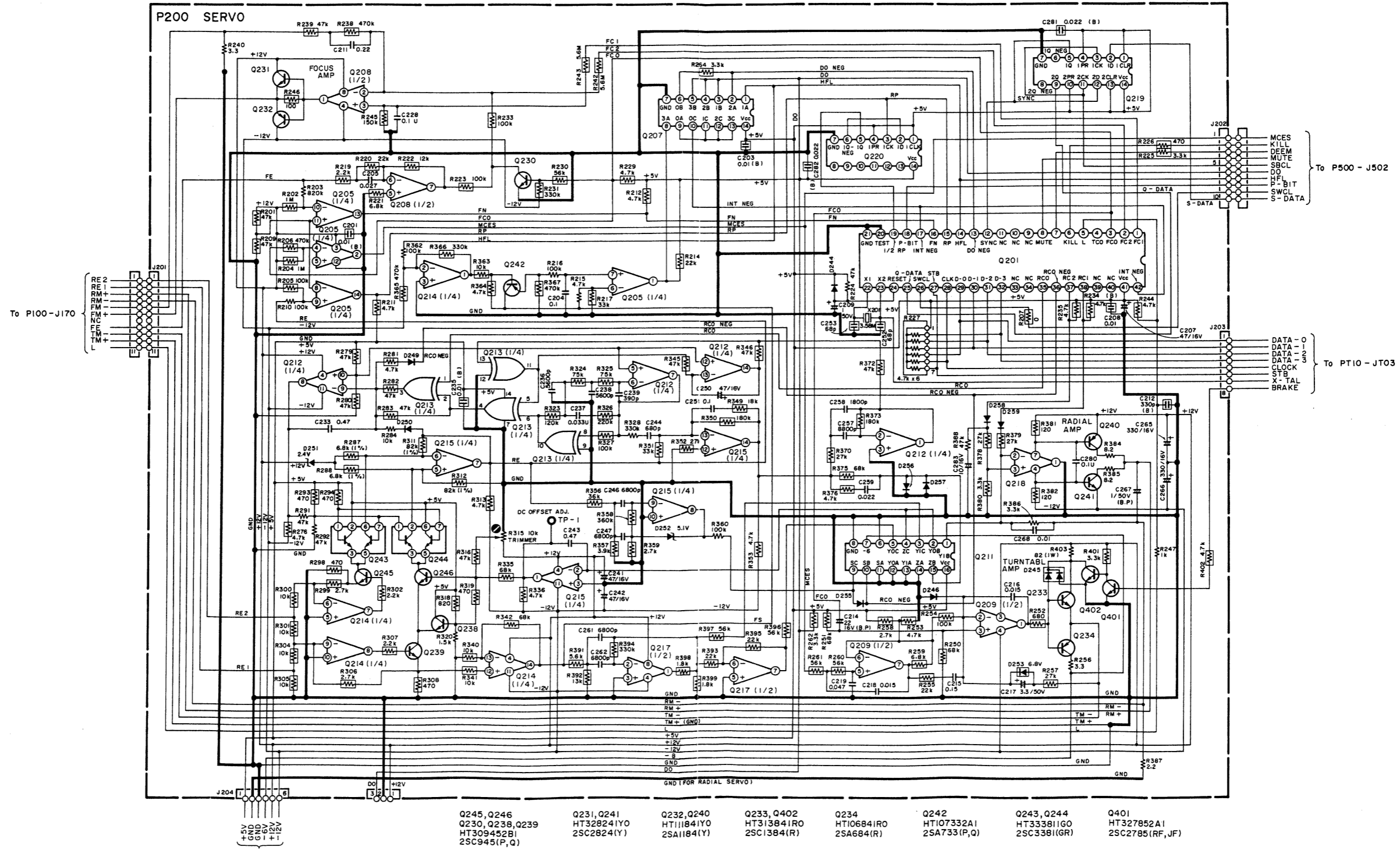
Q211
HC10056010
HDI4053B

Q212, Q214, Q215
HC10082060
μPC324C

Q213
HC10057010
HDI4070B

Q218
HC10083060
μPC741C

Q219, Q220
HC10058010
HD74LS74A



D545 HZ200020Z MAI51WA
 D546, D557, D558 HD20001211 IS2473
 D547 HD20001001 IS2473, IS1555, DS448, MA150

To P200-J202
 S DATA
 SWCL
 P BIT
 HFL
 DO
 SBCL
 MUTE
 DEEM
 KILL
 MCES

D549, D551 HZ2000102Z MAI51WK

D559 HZ2000502Z MAI53

D561, D562 HD40006030 SVC321SP

Q501 HC10022270 SAA7011

Q502-Q504 HT327852A1 2SC2785 (RF, JF)

Q508 HC10084060 μ PC393C

Q510 HC10023270 SAA7020

Q512 HC10098060 μ PD4016C

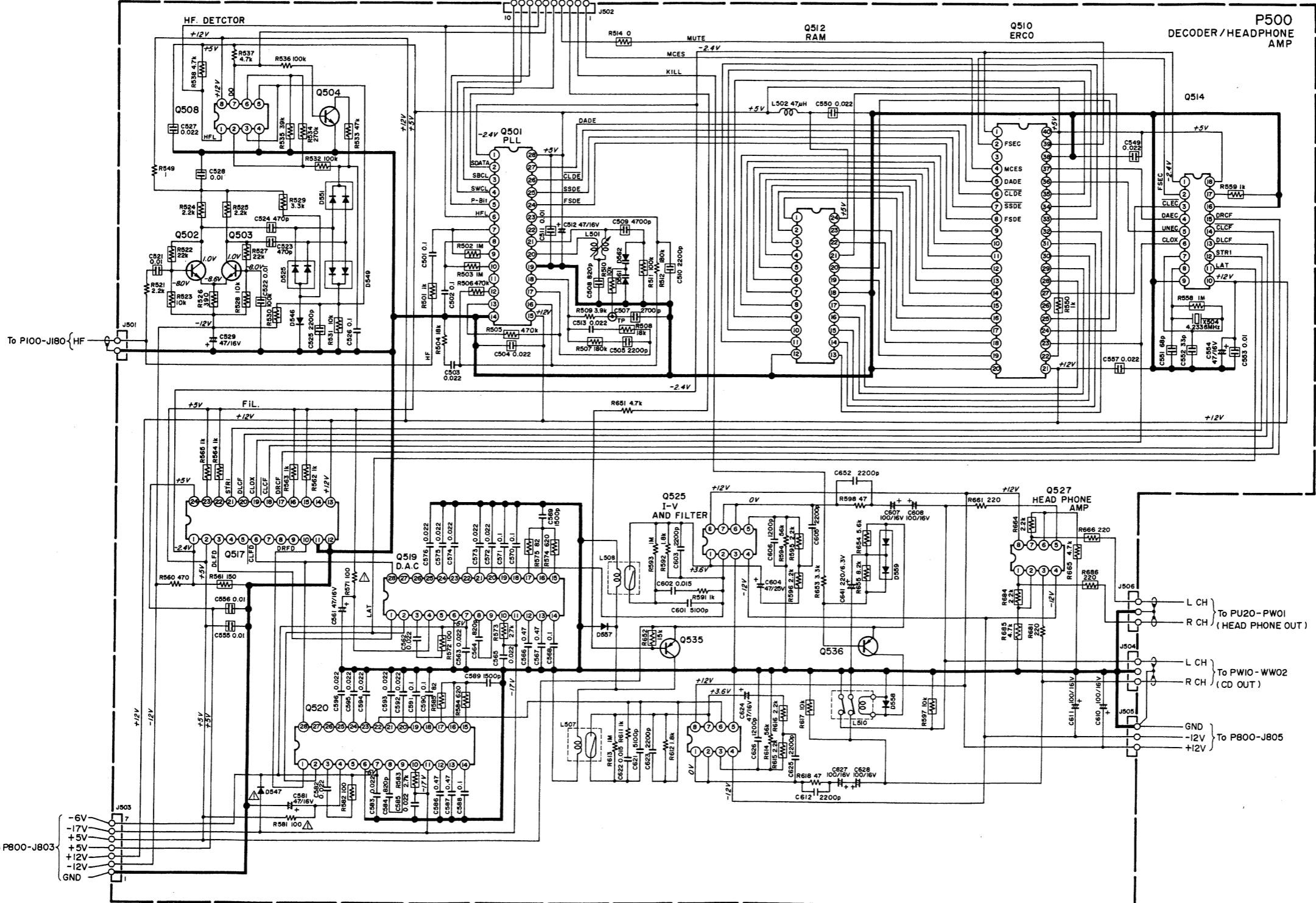
Q514 HC10021270 SAA7000

Q517 HC10024270 SAA7030

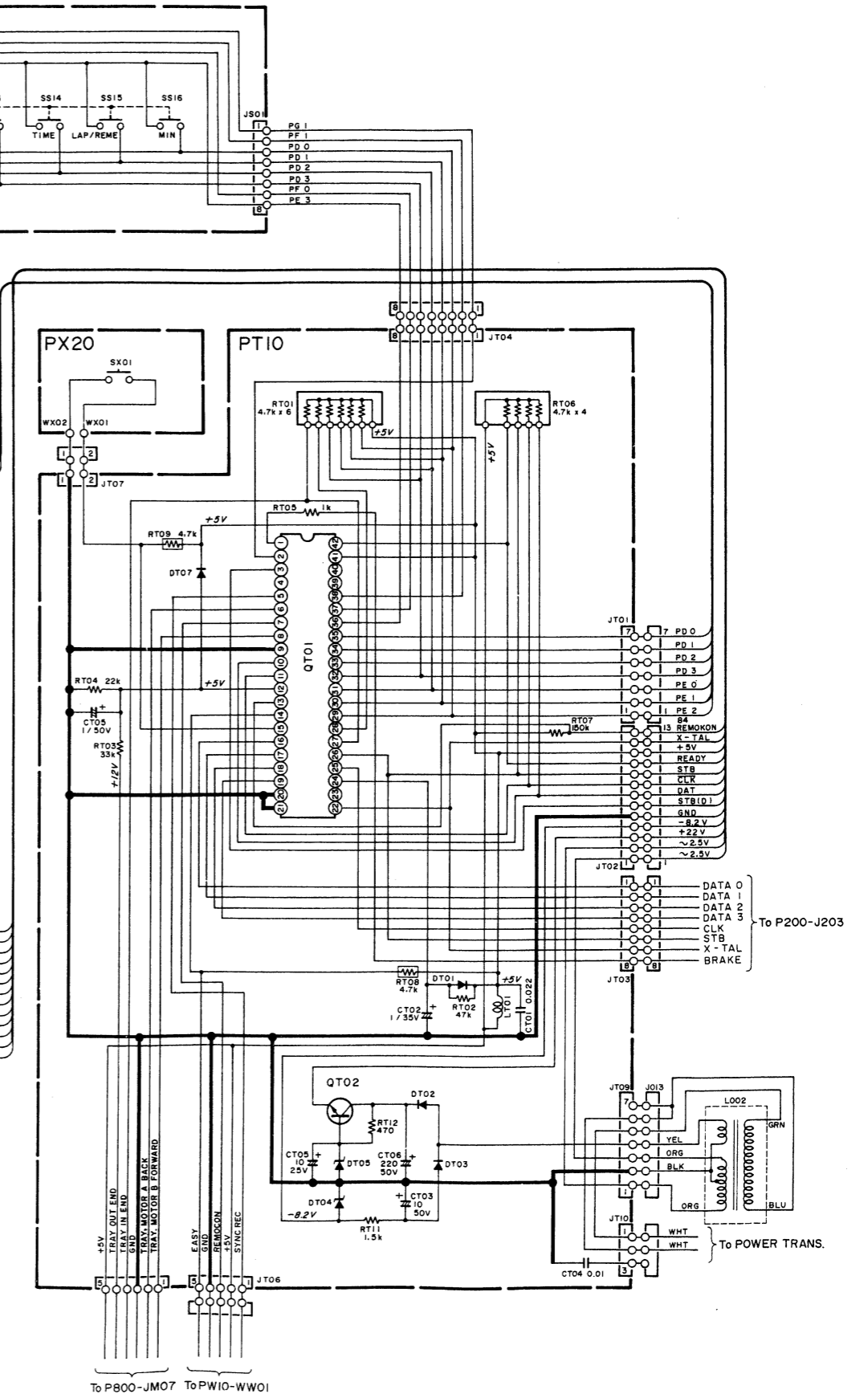
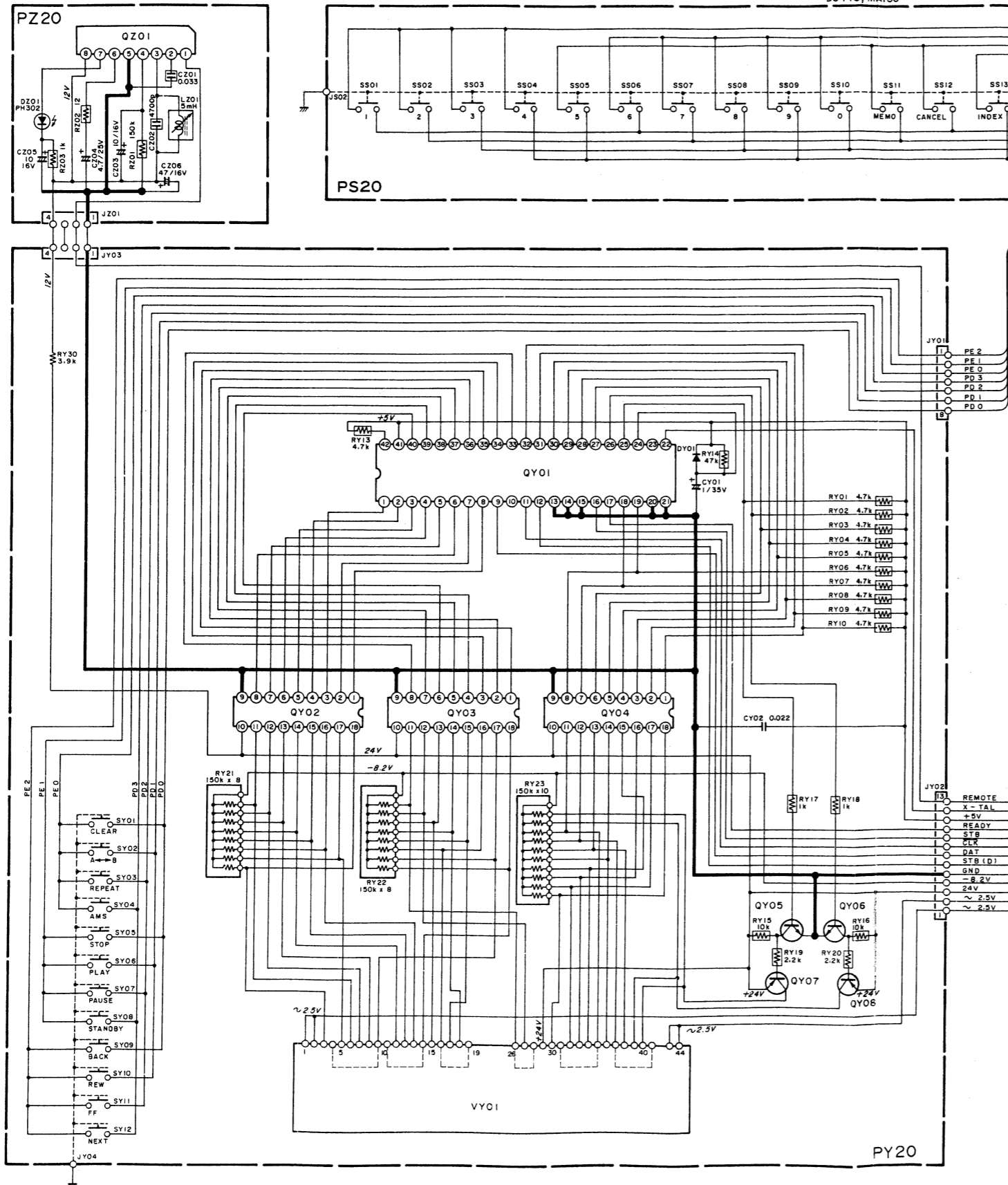
Q519, Q520 HC10025270 TDA1540D

Q523, Q525, Q527 HC10021090 JRC4560DD

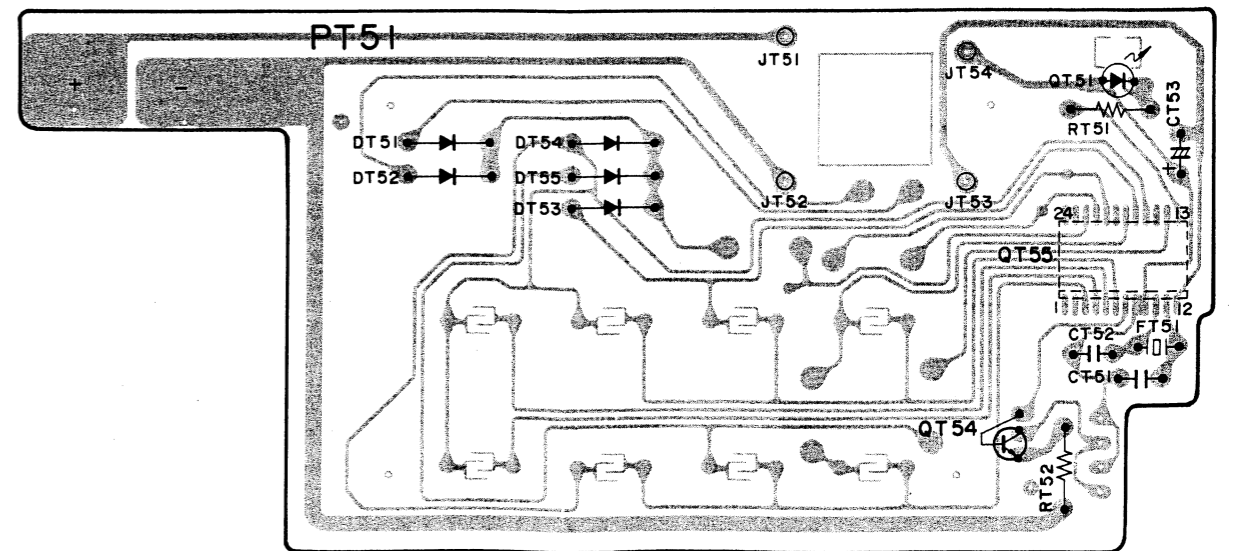
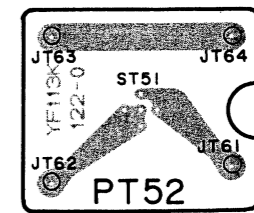
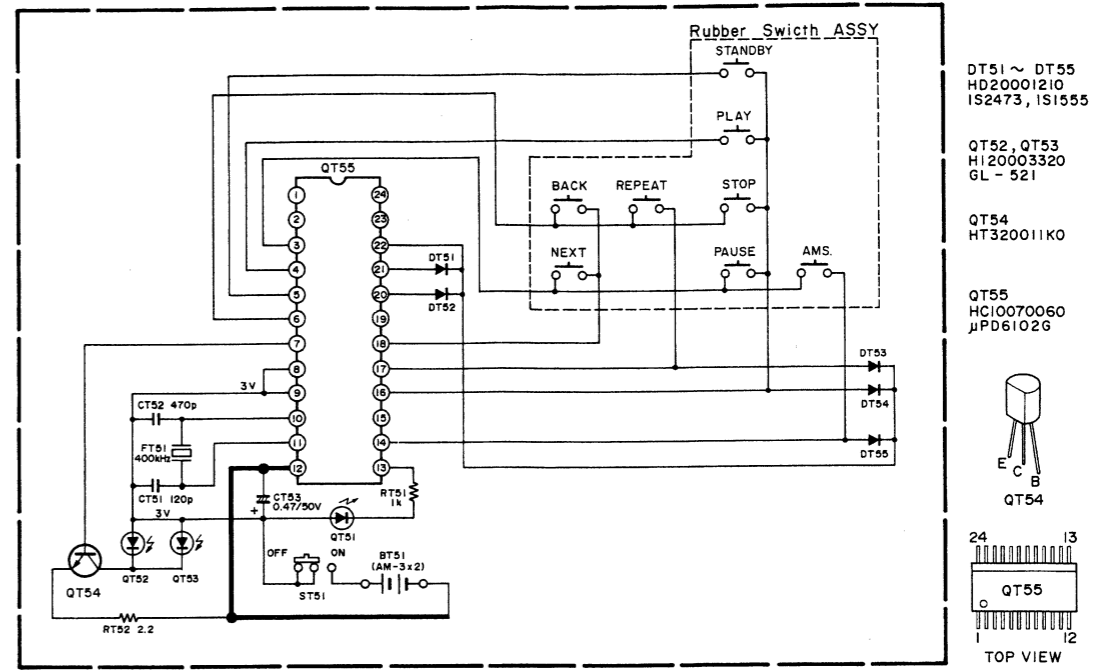
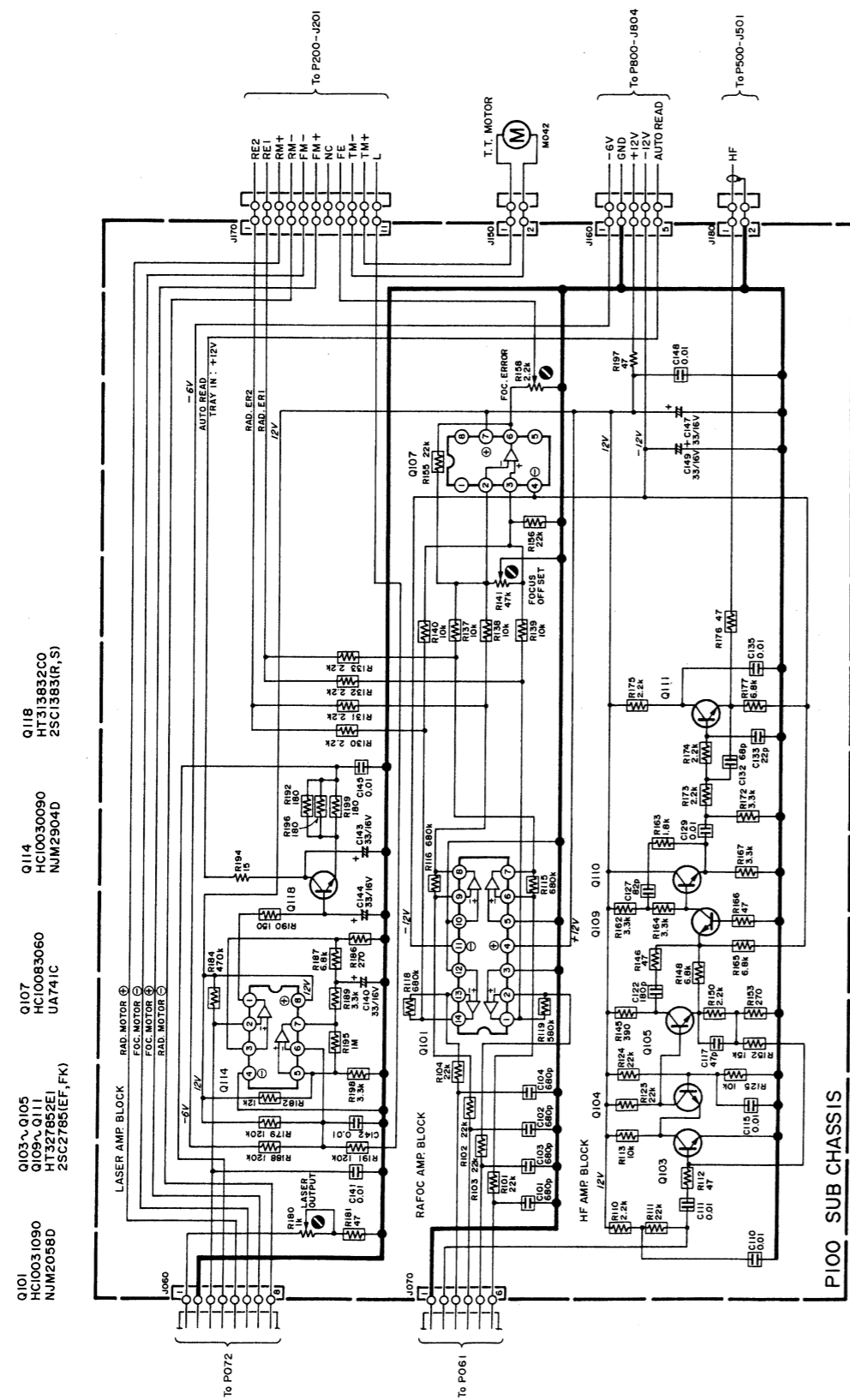
Q535, Q536 HT11752A1 2SA1175 (RF, JF)



QY01 HCl0106060 μPDI510AC
 QY02~QY04 HCl0004260 MSL918RS
 QY05,QY06 HT327852A1 2SC2785(RF,JF)
 QY07,QY08 HT111752A1 2SA1175(RF,JF)
 QZ01 HCl0071060 μPDI373H
 QT01 HCl0104060 μPDI512ACU
 QT02 HT313842A0 2SC1384
 DT01 HD20001001 IS2473,IS1555 DS448, MA150
 DT02 HD20022031 DSF10C
 DT04 HD30043061 RD8.2E
 DT05 HD30022061 RD22E
 DT07 HD20001001 IS2473,IS1555
 DZ01 HI60001060 PH302

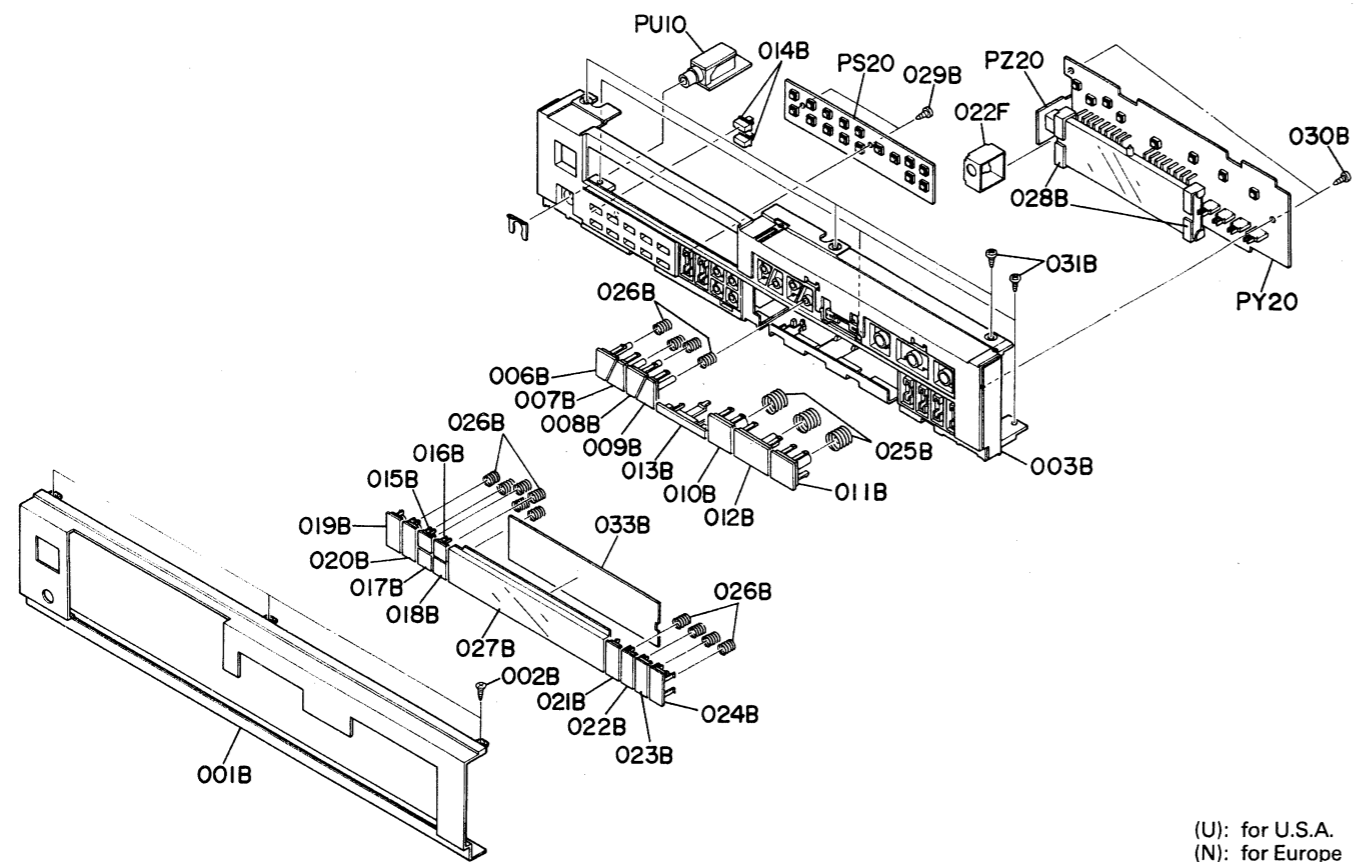


15. REMOTE CONTROLLER (RMC-84) WIRING DIAGRAM AND SCHEMATIC DIAGRAM



16. EXPLODED VIEWS AND PARTS LIST

[C01-99] FRONT PANEL

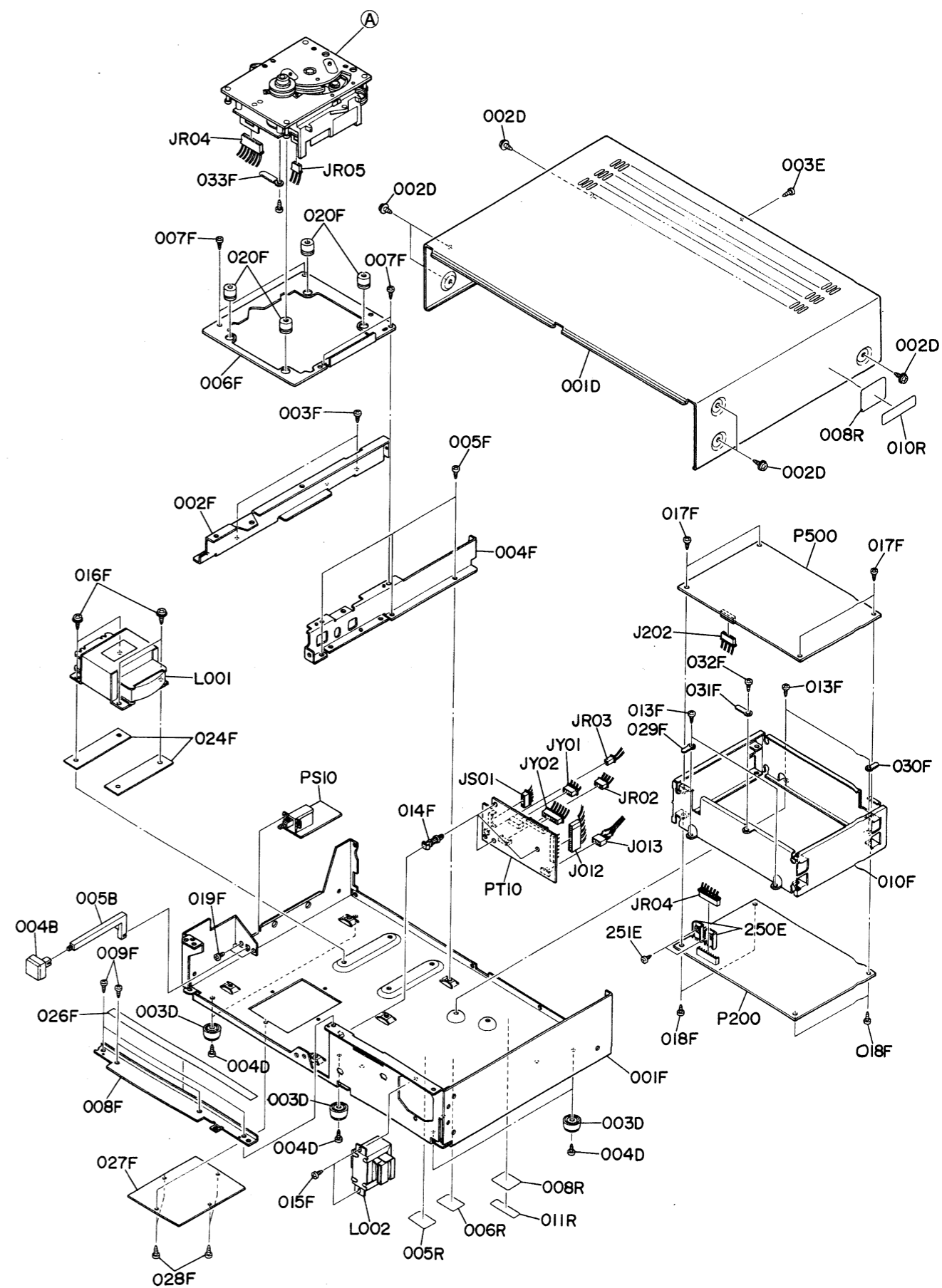


(U): for U.S.A.
 (N): for Europe
 (A): for Australia
 (P): for P.X.
 (F): for Japan

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
001B	1	1	1	1	1	106K248010	Panel, Front
001B					1	106K248050	Panel, Front (BLK)
002B	3	3	3	3	3	51500306B0	F.H. Tapped Screw F3 x 6
003B	1	1	1	1	1	106K248020	Sub Panel, Front
003B					1	106K248060	Sub Panel, Front
006B	1	1	1	1	1	106K270050	Button, Back
006B					1	106K270260	Button, Back
007B	1	1	1	1	1	106K270200	Button, REW
007B					1	106K270270	Button, REW
008B	1	1	1	1	1	106K270210	Button, FF
008B					1	106K270280	Button, FF
009B	1	1	1	1	1	106K270220	Button, Next
009B					1	106K270290	Button, Next
010B	1	1	1	1	1	106K270060	Button, Pause
010B					1	106K270300	Button, Pause
011B	1	1	1	1	1	106K270230	Button, Stop
011B					1	106K270310	Button, Stop
012B	1	1	1	1	1	106K270070	Button, Play
012B					1	106K270320	Button, Play
013B	1	1	1	1	1	106K270080	Button, Standby
013B					1	106K270330	Button, Standby
014B	10	10	10	10	10	106K270030	Button, Ten-key
015B	1	1	1	1	1	106K270020	Button, Index
016B	1	1	1	1	1	106K270120	Button, Lap
017B	1	1	1	1	1	106K270130	Button, Time

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
018B	1	1	1	1	1	106K270140	Button, Min
019B	1	1	1	1	1	106K270040	Button, Memo
020B	1	1	1	1	1	106K270150	Button, Cancel
021B	1	1	1	1	1	106K270160	Button, AMS
022B	1	1	1	1	1	106K270170	Button, Repeat
023B	1	1	1	1	1	106K270180	Button, A & B
024B	1	1	1	1	1	106K270190	Button, Clear
025B	3	3	3	3	3	106K115020	Spring, (L)
026B	14	14	14	14	14	106K115030	Spring, (S)
027B	1	1	1	1	1	106K158010	Window
028B	2	2	2	2	2	106K271020	Holder, Digitron
029B	2	2	2	2	2	51280306B0	B.H. Tapped Screw B3 x 6
030B	2	2	2	2	2	51280306B0	B.H. Tapped Screw B3 x 6
031B	6	6	6	6	6	51280306B0	B.H. Tapped Screw B3 x 6
033B	1	1	1	1	1	106K303010	Mask, Display
022F	1	1	1	1	1	106K109040	Shield, Remocon

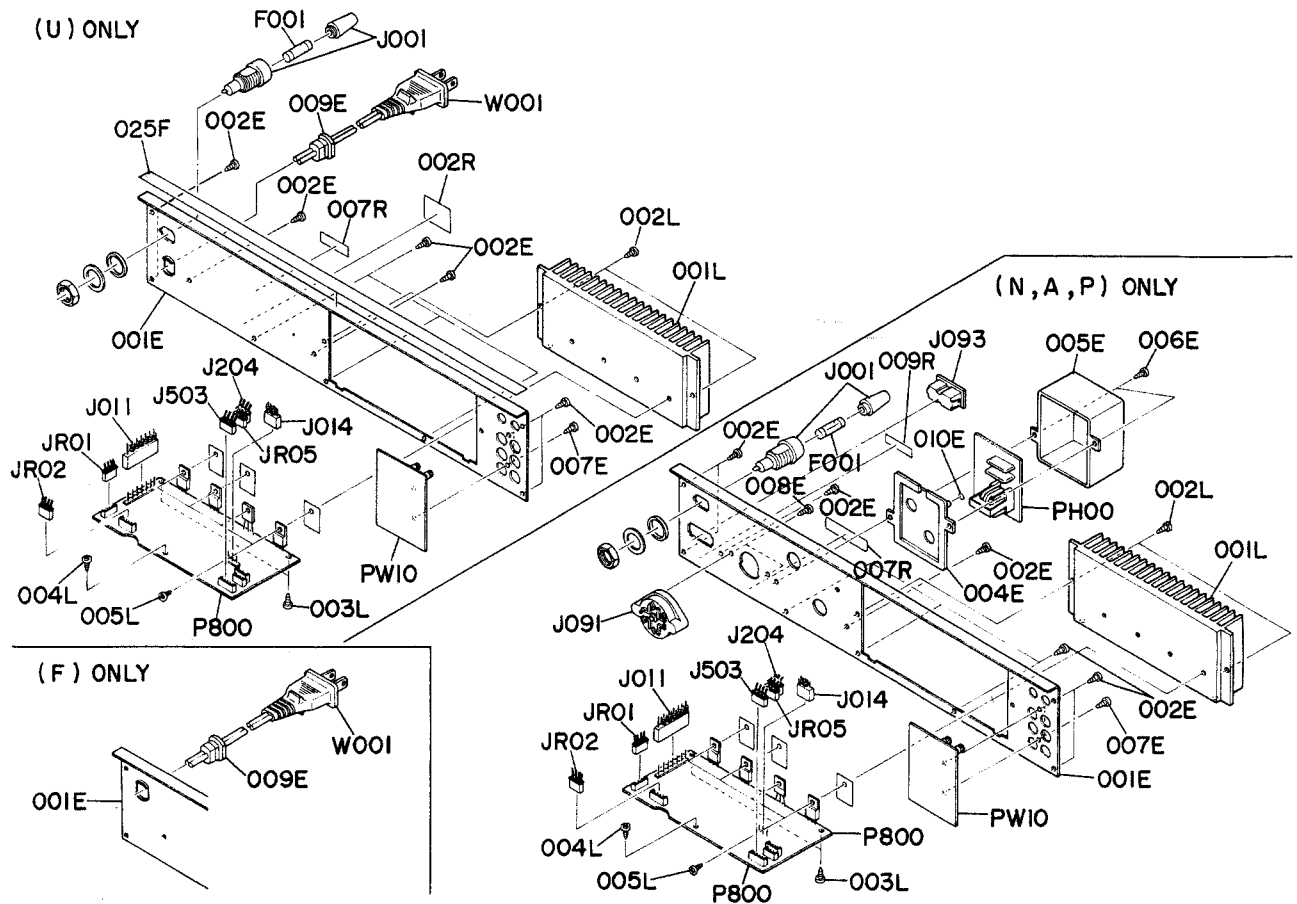
[C02-99] LID (Top/Bottom) & GENERAL PARTS



REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
004B	1	1	1	1		106K270010	Button, Power Switch
004B					1	106K270250	Button, Power Switch
005B	1	1	1	1	1	128T121020	Link, Power Switch
001D	1	1	1	1		106K257010	Lid, Top Cover
001D					1	106K257050	Lid, Top Cover
002D	6	6	6	6		51260408Z0	B.T. Screw B4 x 8
002D					6	51260408U0	B.T. Screw B4 x 8
003D	5	5	5	5	5	416H057010	Leg
004D	5	5	5	5	5	51260308U0	B.T. Screw B3 x 8
003E	1	1	1	1	1	51280306Z0	B.H. Tapped Screw B3 x 6
250E	2	2	2	2	2	415H267010	Heatsink, (Q231, Q232)
251E	2	2	2	2	2	51280306B0	B.H. Tapped Screw B3 x 6
001F	1	1	1	1	1	106K105010	Chassis, Main
002F	1	1	1	1	1	106K160010	Bracket, (L)
003F	2	2	2	2	2	51280306B0	B.H. Tapped Screw B3 x 6
004F	1	1	1	1	1	106K160020	Bracket, (R)
005F	4	4	4	4	4	51280306B0	B.H. Tapped Screw B3 x 6
006F	1	1	1	1	1	106K160070	Bracket, Mecha
007F	4	4	4	4	4	51280306B0	B.H. Tapped Screw B3 x 6
008F	1	1	1	1	1	106K160080	Bracket
009F	4	4	4	4	4	51280306B0	B.H. Tapped Screw B3 x 6
010F	1	1	1	1	1	106K109500	Shield Assembly
013F	4	4	4	4	4	51280306B0	B.H. Tapped Screw B3 x 6
014F	3	3	3	3	3	105K101010	Support
015F	2	2	2	2	2	51280306B0	B.H. Tapped Screw B3 x 6
016F	4	4	4	4	4	51260408B0	B.T. Screw B4 x 8
017F	4	4	4	4	4	51280306B0	B.H. Tapped Screw B3 x 6
018F	4	4	4	4	4	51280306B0	B.H. Tapped Screw B3 x 6
019F	2	2	2	2	2	51100306A9	B.H.M. Screw B3 x 6
020F	4					101K259120	Bushing
020F		4	4	4	4	101K259050	Bushing
024F	2	2	2	2	2	106K118010	Spacer
026F	1	1	1	1	1	200T107040	Sheet

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
027F	1	1	1	1	1	106K257070	Lid, Chassis
028F	4	4	4	4	4	51280306Z0	B.H. Tapped Screw B3 x 6
029F	1	1	1	1	1	62030049W0	Lug
030F	1	1	1	1	1	62030049W0	Lug
031F	1	1	1	1	1	62030049W0	Lug
032F	1	1	1	1	1	51280306Z0	B.H. Tapped Screw B3 x 6
033F	1	1	1	1	1	4220005030	Clamper
005R	1					101K861100	Label, Danger
006R		1	1			105K861070	Label, Class-1
008R		1				117H861010	Label
010R		1	1			2911861140	Label
011R		1	1			2911861110	Label
J012	1	1	1	1	1	YJ06001260	Jack, 7P
J013	1	1	1	1	1	YJ06001040	Jack, 3P
J202	1	1	1	1	1	YB00120110	Connective Cord, 10P
JR02	1	1	1	1	1	YB00320130	Connective Cord, 6P
JR03	1	1	1	1	1	YB00550060	Connective Cord, 2P
JR04	1	1	1	1	1	YB00210080	Connective Cord, 11P
JR05	1	1	1	1	1	YB00420110	Connective Cord, 5P
JS01	1	1	1	1	1	YB00230190	Connective Cord, 8P
JY01	1	1	1	1	1	YB00120150	Connective Cord, 7P
JY02	1	1	1	1	1	YB00230200	Connective Cord, 13P
ΔL001	1					TS17202020	Power Transformer, Main
ΔL001		1	1	1		TS17202030	Power Transformer, Main
ΔL001					1	TS17202010	Power Transformer, Main
ΔL002	1	1	1	1	1	TS14139010	Power Transformer, Sub
A	1	1	1	1	1	107K105400	CDP-3 Assembly, HF-AMP+CHASSIS(K)

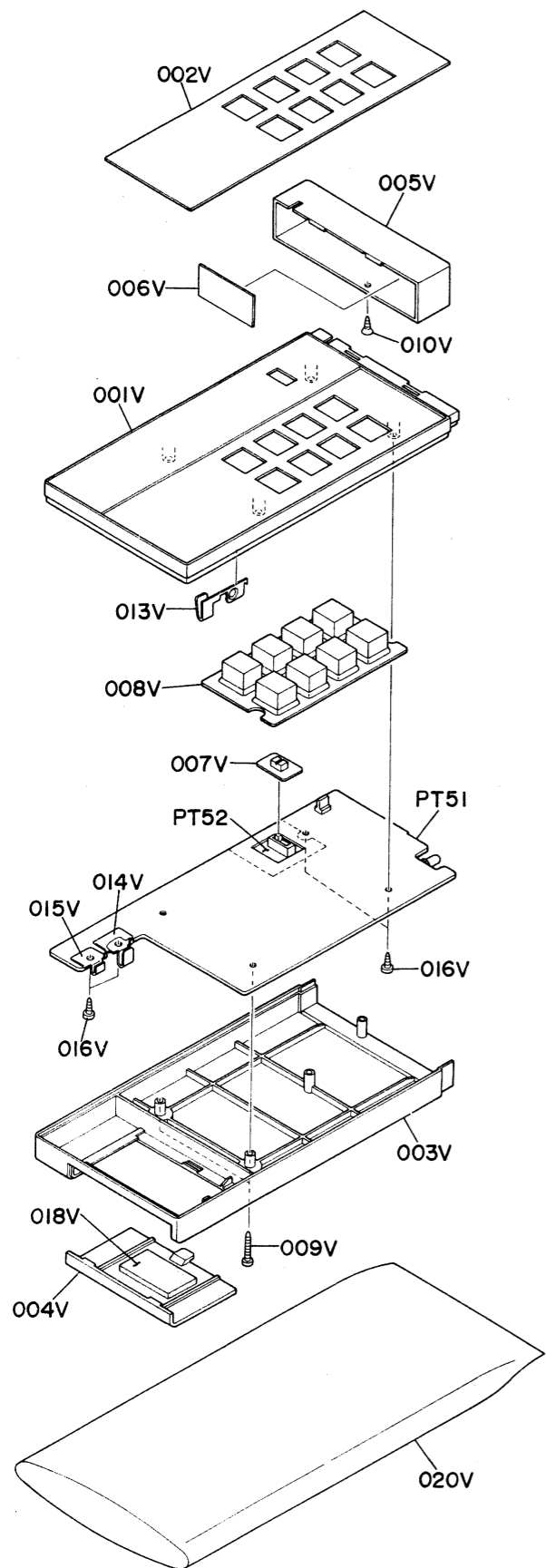
[C03-99] REAR PANEL



REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
001E	1					106K250030	Rear Panel
001E		1	1	1		106K250020	Rear Panel
001E					1	106K250010	Rear Panel
002E	9	9	9	9	9	51280306U0	B.H. Tapped Screw B3 x 6
004E	1	1	1	1		101K064020	Case, Filter; Bottom
005E	1	1	1	1		101K064030	Case, Filter; Top
006E	2	2	2	2		51280310U0	B.H. Tapped Screw B3 x 10
007E	2	2	2	2	2	51280308U0	B.H. Tapped Screw B3 x 8
008E		2	2	2		51280308U0	B.H. Tapped Screw B3 x 8
009E	1				1	1455259090	Bushing, AC Power Cord
010E	1	1	1			101K056020	Buffer, Filter Case
025F	1	1	1	1	1	106K107010	Sheet
001L	1	1	1	1	1	106K267010	Heatsink, Main
002L	2	2	2	2	2	51280306U0	B.H. Tapped Screw B3 x 6
003L	2	2	2	2	2	51280306U0	B.H. Tapped Screw B3 x 6
004L	1	1	1	1	1	51280306B0	B.H. Tapped Screw B3 x 6
005L	4	4	4	4	4	51280308M0	B.H. Tapped Screw B3 x 8
002R					1	101K861030	Label
007R	1					2112265010	Indicator, Serial No.
007R		1	1	1	1	2112265110	Indicator, Serial No.
009R		1	1	1		4581861010	Label, Made in Japan

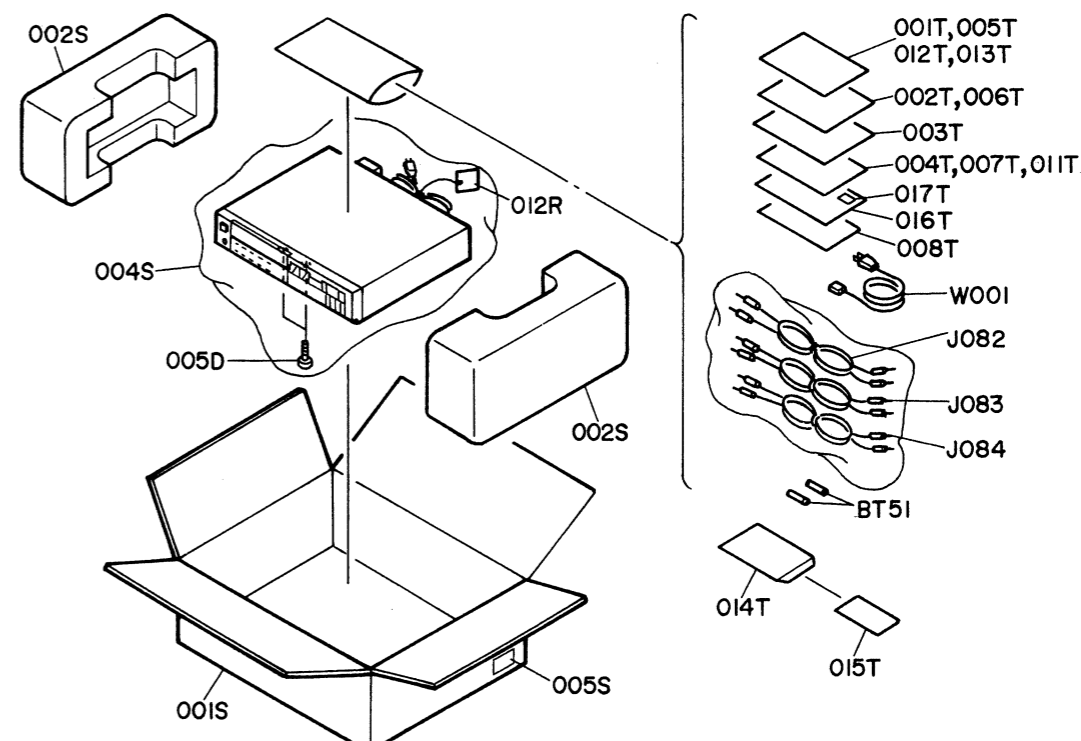
REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
△F001	1					FS10100500	Fuse, 1A 250V
△F001		1	1			FS10025800	Fuse, 250mA 250V
△F001					1	FS10100700	Fuse, 1A 250V
△J001	1					YJ08000300	Jack, Fuse Holder
△J001		1	1	1		YJ08000290	Jack, Fuse Holder
J011	1	1	1	1	1	YJ06001060	Jack, 7P
J014	1	1	1	1	1	YJ06001040	Jack, 3P
J204	1	1	1	1	1	YB00280250	Connective Cord, 6P
J503	1	1	1	1	1	YB00130190	Connective Cord, 7P
△J091		1	1	1		BY05080050	Voltage Selector
△J093		1	1	1		YP04000580	Plug, AC Inlet
JR01	1	1	1	1	1	YB00480030	Connective Cord, 6P
JR02	1	1	1	1	1	YB00320130	Connective Cord, 6P
JR05	1	1	1	1	1	YB00420110	Connective Cord, 5P
△W001	1					YC02000160	A.C. Power Cord
△W001					1	YC01800200	A.C. Power Cord

[C05-99] REMOTE CONTROL (RMC-84)



REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
001V	1	1	1			116K064030	Case, Front
001V					1	116K064020	Case, Front
002V	1	1	1			116K063040	Escutcheon, Front Case
002V					1	116K063030	Escutcheon, Front Case
003V	1	1	1			017H064020	Case, Rear
003V					1	017H064320	Case, Rear
004V	1	1	1			017H064030	Case, Battery
004V					1	017H064330	Case, Battery
005V	1	1	1			017H401320	Frame, Top
005V					1	017H401220	Frame, Top
006V	1	1	1			017H158020	Window
007V	1	1	1			116K154020	Knob, ON/OFF
007V					1	116K154010	Knob, ON/OFF
008V	1	1	1			116K127030	Control Board
008V					1	116K127020	Control Board
009V	2	2	2			51402612R0	B.H. Tapped Screw B2.6 x 12
009V					2	51402612T0	B.H. Tapped Screw B2.6 x 12
010V	1	1	1			51420206R0	O.C.H. Tapped Screw O2 x 6
010V					1	51420206T0	O.C.H. Tapped Screw O2 x 6
013V	1	1	1			116K123010	Contactior
014V	1	1	1			017H123010	Contactior
015V	1	1	1			017H123030	Contactior
016V	4	4	4			51302606B0	P.H. Tapped Screw P2.6 x 6
018V	1	1	1			4724056010	Buffer
020V	1	1	1			9011325010	Polyethylene Bag

[P01-99] PACKING MATERIALS



REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
001S	1					106K801020	Packing Case
001S		1	1	1	1	106K801010	Packing Case
002S	2	2	2	2	2	106K809010	Cushion
004S	1	1	1	1	1	9090808030	Polyethylene Sheet
005S	2					9526019010	Serial No. Card
005S		4				9526019060	Serial No. Card
005S			4			9526019030	Serial No. Card
005S				4		9526019050	Serial No. Card
005S					4	9526019040	Serial No. Card
001T	1	1	1			106K851310	User Manual
002T	1	1	1			106K851320	User Manual, Spec
003T	1	1	1			106K856010	Circuit Diagram
004T			1			9631000090	Warrantee Card
005T	1					106K851210	User Manual
006T	1					106K851220	User Manual, Spec
007T	1					103H854010	Warrantee Card
008T	1					2225813010	Envelope
011T				1		416H854010	Warrantee Card
012T					1	3435851210	User Manual
013T					1	106K851110	User Manual
014T					1	9631000130	Warrantee Card
015T					1	128T854010	Warrantee Card
016T					1	9611000050	User's Card
017T					1	9540000010	Licence

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
005D	2	2	2	2	2	51100345Y9	B.H.M. Screw(RED) B3 x 45
012R	1					9560000100	Hang Tag
BT51	2	2	2	2	2	ZB05030010	Battery, AM-3
J082	1	1	1	1	1	ZD01000170	Connective Cord, Audio Out
J083	1	1	1	1	1	ZD01000220	Connective Cord, Easy Out
J084	1	1	1	1	1	ZD01000250	Connective Cord, Remote
ΔW001		1				ZC01805010	A.C. Power Cord
ΔW001			1			ZC02006020	A.C. Power Cord
ΔW001				1		ZC01807010	A.C. Power Cord

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
J201	1	1	1	1	1	YJ06003110	P200-MISCELLANEOUS Jack, 11P
X201	1	1	1	1	1	FQ03504010	Ceramic Vibrator, 3.58MHz
P500	1	1	1	1	1	WB106K1810	P.W. Board, Decoder Head- phone Amp
	1	1	1	1	1	ZZ106K1810	P.W. Board Assembly
P500-CAPACITORS							
C501	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C502	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C503	1	1	1	1	1	DF74223030	Film 0.022μF ±2%
C504	1	1	1	1	1	DK46223300	Ceramic 0.022μF ±10%,Chip
C505	1	1	1	1	1	DK46222300	Ceramic 2200pF ±10%,Chip
C507	1	1	1	1	1	DK46272300	Ceramic 2700pF ±10%,Chip
C508	1	1	1	1	1	DK46821300	Ceramic 820pF ±10%,Chip
C509	1	1	1	1	1	DK46472300	Ceramic 4700pF ±10%,Chip
C510	1	1	1	1	1	DK46222300	Ceramic 2200pF ±10%,Chip
C511	1	1	1	1	1	DK46103300	Ceramic 0.01μF ±10%,Chip
C512	1	1	1	1	1	OA47601610	Elect 47μF 16V
C513	1	1	1	1	1	DF74223030	Film 0.022μF ±2%
C521	1	1	1	1	1	DK46103300	Ceramic 0.01μF ±10%,Chip
C522	1	1	1	1	1	DK46103300	Ceramic 0.01μF ±10%,Chip
C523	1	1	1	1	1	DK46471300	Ceramic 470pF ±10%,Chip
C524	1	1	1	1	1	DK46471300	Ceramic 470pF ±10%,Chip
C525	1	1	1	1	1	DK46222300	Ceramic 2200pF ±10%,Chip
C526	1	1	1	1	1	DF15104310	Film 0.1μF ±5%
C528	1	1	1	1	1	DK46103300	Ceramic 0.01μF ±10%,Chip
C529	1	1	1	1	1	OA47601610	Elect 47μF 16V
C549	1	1	1	1	1	DK46223300	Ceramic 0.022μF ±10%,Chip
C550	1	1	1	1	1	DK46223300	Ceramic 0.022pF ±10%,Chip
C551	1	1	1	1	1	DD45680300	Ceramic 68pF ±5%,Chip
C552	1	1	1	1	1	DD45330300	Ceramic 33pF ±5%,Chip
C553	1	1	1	1	1	DK46103300	Ceramic 0.01μF ±10%,Chip
C554	1	1	1	1	1	OA47601610	Elect 47μF 16V
C555	1	1	1	1	1	DK46103300	Ceramic 0.01μF ±10%,Chip
C556	1	1	1	1	1	DK46103300	Ceramic 0.01μF ±10%,Chip
C557	1	1	1	1	1	DK46223300	Ceramic 0.022μF ±10%,Chip
C561	1	1	1	1	1	EA47602560	Elect 47μF 25V
C562	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C563	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C564	1	1	1	1	1	DK16821300	Ceramic 820pF ±10%
C565	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C566	1	1	1	1	1	DF15474350	Film 0.47μF ±5%
C567	1	1	1	1	1	DF15474350	Film 0.47μF ±5%
C568	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C569	1	1	1	1	1	DF16152310	Film 1500pF ±10%
C570	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C571	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C572	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C573	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C574	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C575	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C576	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C576	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C581	1	1	1	1	1	EA47602560	Elect 47μF 25V
C582	1	1	1	1	1	DF16223310	Film 0.022μF ±10%

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
C583	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C584	1	1	1	1	1	DK16821300	Ceramic 820pF ±10%
C585	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C586	1	1	1	1	1	DF15474350	Film 0.47μF ±5%
C587	1	1	1	1	1	DF15474350	Film 0.47μF ±5%
C588	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C589	1	1	1	1	1	DF16152310	Film 1500pF ±10%
C590	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C591	1	1	1	1	1	DF16104310	Film 0.1μF ±10%
C592	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C593	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C594	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C595	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C596	1	1	1	1	1	DF16223310	Film 0.022μF ±10%
C601	1	1	1	1	1	DF55512530	Film 5100pF ±5%
C602	1	1	1	1	1	DF74153010	Film 0.015μF ±2%
C603	1	1	1	1	1	DF55222530	Film 2200pF ±5%
C604	1	1	1	1	1	EA47602560	Elect 47μF 25V
C605	1	1	1	1	1	DF55222530	Film 2200pF ±5%
C606	1	1	1	1	1	DF55122530	Film 1200pF ±5%
C607	1	1	1	1	1	EA10701660	Elect 100μF 16V
C608	1	1	1	1	1	EA10701660	Elect 100μF 16V
C610	1	1	1	1	1	OA10701610	Elect 100μF 16V
C611	1	1	1	1	1	OA10701610	Elect 100μF 16V
C612	1	1	1	1	1	DF55222510	Film 2200pF ±5%
C621	1	1	1	1	1	DF55512530	Film 5100pF ±5%
C622	1	1	1	1	1	DF74153010	Film 0.015μF ±2%
C623	1	1	1	1	1	DF55222530	Film 2200pF ±5%
C624	1	1	1	1	1	EA47602560	Elect 47μF 25V
C625	1	1	1	1	1	DF55222530	Film 2200pF ±5%
C626	1	1	1	1	1	DF55122530	Film 1200pF ±5%
C627	1	1	1	1	1	EA10701660	Elect 100μF 16V
C628	1	1	1	1	1	EA10701660	Elect 100μF 16V
C641	1	1	1	1	1	OA22700610	Elect 220μF 6.3V
C652	1	1	1	1	1	DF55222510	Film 2200pF ±5%
P500-RESISTORS (All Resistors are ±5% & 1/8W)							
R501	1	1	1	1	1	RI05102180	1KΩ, Chip
R502	1	1	1	1	1	RI05105180	1MΩ, Chip
R503	1	1	1	1	1	RI05105180	1MΩ, Chip
R504	1	1	1	1	1	GD05183140	18KΩ ¼W
R505	1	1	1	1	1	RI05474180	470KΩ, Chip
R506	1	1	1	1	1	RI05474180	470KΩ, Chip
R507	1	1	1	1	1	RI05184180	180KΩ, Chip
R508	1	1	1	1	1	RI05183180	18KΩ, Chip
R509	1	1	1	1	1	GD05392140	3.9KΩ ¼W
R510	1	1	1	1	1	RI05103180	10KΩ, Chip
R511	1	1	1	1	1	RI05104180	100KΩ, Chip
R512	1	1	1	1	1	GD05184140	180KΩ ¼W
R514	1	1	1	1	1	RI05000180	0Ω, Chip
R521	1	1	1	1	1	GD05222140	2.2KΩ ¼W
R522	1	1	1	1	1	RI05223180	22KΩ, Chip
R523	1	1	1	1	1	RI05103180	10KΩ, Chip
R524	1	1	1	1	1	RI05222180	2.2KΩ, Chip
R525	1	1	1	1	1	RI05222180	2.2KΩ, Chip
R526	1	1	1	1	1	RI05391180	390Ω, Chip
R527	1	1	1	1	1	RI05223180	22KΩ, Chip

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
R528	1	1	1	1	1	RI05103180	10K Ω , Chip
R529	1	1	1	1	1	RI05332180	3.3K Ω , Chip
R530	1	1	1	1	1	RI05104180	100K Ω , Chip
R531	1	1	1	1	1	RI05103180	10K Ω , Chip
R532	1	1	1	1	1	RI05104180	100K Ω , Chip
R533	1	1	1	1	1	RI05473180	47K Ω , Chip
R534	1	1	1	1	1	RI05274180	270K Ω , Chip
R535	1	1	1	1	1	RI05393180	39K Ω , Chip
R536	1	1	1	1	1	GD05104140	100K Ω $\frac{1}{4}$ W
R537	1	1	1	1	1	GD05472140	4.7K Ω $\frac{1}{4}$ W
R538	1	1	1	1	1	RI05472180	4.7K Ω , Chip
R549	1	1	1	1	1	GD05010140	1 Ω $\frac{1}{4}$ W
R550	1	1	1	1	1	RI05102180	1K Ω , Chip
R558	1	1	1	1	1	RI05105180	1M Ω , Chip
R559	1	1	1	1	1	RI05102180	1K Ω , Chip
R560	1	1	1	1	1	GD05471140	470 Ω $\frac{1}{4}$ W
R561	1	1	1	1	1	RI05151180	150 Ω , Chip
R562	1	1	1	1	1	RI05102180	1K Ω , Chip
R563	1	1	1	1	1	RI05102180	1K Ω , Chip
R564	1	1	1	1	1	RI05102180	1K Ω , Chip
R565	1	1	1	1	1	RI05102180	1K Ω , Chip
Δ R571	1	1	1	1	1	GG05101140	100 Ω $\frac{1}{4}$ W
R572	1	1	1	1	1	RI05101180	100 Ω , Chip
R573	1	1	1	1	1	RI05272180	2.7K Ω , Chip
R574	1	1	1	1	1	RI05621180	620 Ω , Chip
R575	1	1	1	1	1	RI05820180	82 Ω , Chip
Δ R581	1	1	1	1	1	GG05101140	100 Ω $\frac{1}{4}$ W
R582	1	1	1	1	1	RI05101180	100 Ω , Chip
R583	1	1	1	1	1	RI05272180	2.7K Ω , Chip
R584	1	1	1	1	1	RI05621180	620 Ω , Chip
R585	1	1	1	1	1	RI05820180	82 Ω , Chip
R591	1	1	1	1	1	GD05102140	1K Ω $\frac{1}{4}$ W
R592	1	1	1	1	1	GM21417810	1.78K Ω $\pm 2\%$ $\frac{1}{4}$ W
R593	1	1	1	1	1	GD05105140	1M Ω $\frac{1}{4}$ W
R594	1	1	1	1	1	GM21456220	56.2K Ω $\pm 2\%$ $\frac{1}{4}$ W
R595	1	1	1	1	1	RI05222180	2.2K Ω , Chip
R596	1	1	1	1	1	RI05222180	2.2K Ω , Chip
R597	1	1	1	1	1	RI05103180	10K Ω , Chip
R598	1	1	1	1	1	GM214464G0	46.4 Ω $\pm 2\%$ $\frac{1}{4}$ W
R611	1	1	1	1	1	GD05102140	1K Ω $\frac{1}{4}$ W
R612	1	1	1	1	1	GM21417810	1.78K Ω $\pm 2\%$ $\frac{1}{4}$ W
R613	1	1	1	1	1	GD05105140	1M Ω $\frac{1}{4}$ W
R614	1	1	1	1	1	GM21456220	56.2K Ω $\pm 2\%$ $\frac{1}{4}$ W
R615	1	1	1	1	1	RI01222180	2.2K Ω , Chip $\pm 1\%$
R616	1	1	1	1	1	RI01222180	2.2K Ω , Chip $\pm 1\%$
R617	1	1	1	1	1	RI05103180	10K Ω , Chip
R618	1	1	1	1	1	GM214464G0	46.4 Ω $\pm 2\%$ $\frac{1}{4}$ W
R623	1	1	1	1	1	RI05000180	0 Ω , Chip
R651	1	1	1	1	1	GD05472140	4.7K Ω $\frac{1}{4}$ W
R652	1	1	1	1	1	RI05153180	15K Ω , Chip
R653	1	1	1	1	1	GD05332140	3.3K Ω $\frac{1}{4}$ W
R654	1	1	1	1	1	RI05562180	5.6K Ω , Chip
R655	1	1	1	1	1	RI05822180	8.2K Ω , Chip
R661	1	1	1	1	1	GD05221140	220 Ω $\frac{1}{4}$ W
R664	1	1	1	1	1	RI05222180	2.2K Ω , Chip
R665	1	1	1	1	1	RI05472180	4.7K Ω , Chip
R666	1	1	1	1	1	RI05221180	220 Ω , Chip
R681	1	1	1	1	1	GD05221140	220 Ω $\frac{1}{4}$ W
R684	1	1	1	1	1	RI05222180	2.2K Ω , Chip
R685	1	1	1	1	1	RI05472180	4.7K Ω , Chip
R686	1	1	1	1	1	RI05221180	220 Ω , Chip

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
P500-SEMICONDUCTORS							
D545	1	1	1	1	1	HZ20002020	Diode MA151WA, Chip
D546	1	1	1	1	1	HD20001210	Diode 1S2473
Δ D547	1	1	1	1	1	HD20001000	Diode 1S1555
D549	1	1	1	1	1	HZ20001020	Diode MA151WA,Chip
D551	1	1	1	1	1	HZ20001020	Diode MA151WA,Chip
D557	1	1	1	1	1	HD20001210	Diode 1S2473
D558	1	1	1	1	1	HD20001210	Diode 1S2473
D559	1	1	1	1	1	HZ20005020	Diode MA153, Chip
D561	1	1	1	1	1	HD40006030	Varicap SVC321SP
D562	1	1	1	1	1	HD40006030	Varicap SVC321SP
Q501	1	1	1	1	1	HC10022270	IC SAA7011
Q502	1	1	1	1	1	HT327852A0	Transistor 2SC2785(RF,JF)
Q503	1	1	1	1	1	HT327852A0	Transistor 2SC2785(RF,JF)
Q504	1	1	1	1	1	HT327852A0	Transistor 2SC2785(RF,JF)
Q508	1	1	1	1	1	HC10084060	IC μ PC393C
Q510	1	1	1	1	1	HC10023270	IC SAA7020
Q512	1	1	1	1	1	HC10098060	IC μ PD4016C
Q514	1	1	1	1	1	HC10021270	IC SAA7000
Q517	1	1	1	1	1	HC10024270	IC SAA7030
Q519	1	1	1	1	1	HC10025270	IC TDA1540D
Q520	1	1	1	1	1	HC10025270	IC TDA1540D
Q523	1	1	1	1	1	HC10021090	IC 4560DD
Q525	1	1	1	1	1	HC10021090	IC 4560DD
Q527	1	1	1	1	1	HC10021090	IC 4560DD
Q535	1	1	1	1	1	HT111752A0	Transistor 2SA1175(RF,JF)
Q536	1	1	1	1	1	HT111752A0	Transistor 2SA1175(RF,JF)
P500-MISCELLANEOUS							
J502	1	1	1	1	1	YJ06003100	Jack, 10P
J505	1	1	1	1	1	YP06001040	Plug, 3P
L501	1	1	1	1	1	LO74013050	OSC Coil, 7.5 μ H
L502	1	1	1	1	1	LC14730040	Choke Coil, 47 μ H
L507	1	1	1	1	1	LY10050040	Relay, Reed
L508	1	1	1	1	1	LY10050040	Relay, Reed
L510	1	1	1	1	1	LY20045010	Relay, SZ-2101
X504	1	1	1	1	1	XB108002L2	Crystal, 4.2336MHz
P800-POWER SUPPLY CIRCUIT BOARD							
P800	1	1	1	1	1	WB106K1830	P.W. Board, Power Supply
	1	1	1	1	1	ZZ106K1830	P.W. Board Assembly
P800-CAPACITORS							
CM03	1	1	1	1	1	DF16104310	Film 0.1 μ F $\pm 10\%$
CM04	1	1	1	1	1	DK46103300	Ceramic 0.01 μ F $\pm 10\%$,Chip
C803	1	1	1	1	1	OA47801610	Elect 4700 μ F 16V
C804	1	1	1	1	1	OA22701610	Elect 220 μ F 16V
C806	1	1	1	1	1	OA10801610	Elect 1000 μ F 16V
C808	1	1	1	1	1	OA22701610	Elect 220 μ F 16V
C812	1	1	1	1	1	OA33802510	Elect 3300 μ F 25V
C812	1	1	1	1	1	EB68802530	Elect 6800 μ F 25V
C813	1	1	1	1	1	OA33802510	Elect 3300 μ F 25V
C813	1	1	1	1	1	EB68802530	Elect 6800 μ F 25V
C814	1	1	1	1	1	OA22701610	Elect 220 μ F 16V
C815	1	1	1	1	1	OA10601610	Elect 10 μ F 16V
C819	1	1	1	1	1	OA22701610	Elect 220 μ F 16V
C821	1	1	1	1	1	OA10701010	Elect 100 μ F 10V
Δ C822	1	1	1	1	1	OA10702510	Elect 100 μ F 25V
C824	1	1	1	1	1	OA33705010	Elect 330 μ F 50V

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
P800-RESISTORS (All Resistors are $\pm 5\%$ & 1/8W)							
R801					1	GD05101140	100 Ω
R805	1	1	1	1	1	GD05681140	680 Ω
R809	1	1	1	1	1	GD05561140	560 Ω
R810	1	1	1	1	1	GD05102140	1K Ω
RM01	1	1	1	1	1	GD05183140	18K Ω
RM02	1	1	1	1	1	GD05223140	22K Ω
Δ RM05	1	1	1	1	1	NF05047140	4.7 Ω , Fuse
Δ RM05					1	GD05047140	4.7 Ω
RM07	1	1	1	1	1	RI05473180	47K Ω 1/8W,Chip
P800-SEMICONDUCTORS							
Δ D801	1	1	1	1	1	HD20026080	Diode RB151
D802	1	1	1	1	1	HD20022030	Diode DSF10C-BT
Δ D803	1	1	1	1	1	HD20021290	Diode S1VB20
Δ D804	1	1	1	1	1	HD20022030	Diode DSF10C-BT
Δ D805	1	1	1	1	1	HD20022030	Diode DSF10C-BT
Δ D806	1	1	1	1	1	HD20022030	Diode DSF10C-BT
D807	1	1	1	1	1	HD30040060	Zener RD5.6E
D808	1	1	1	1	1	HD30041060	Zener RD6.8E
D809	1	1	1	1	1	HD30040060	Zener RD5.6E
DM01	1	1	1	1	1	HD30043060	Zener RD8.2E
Δ Q801	1	1	1	1	1	FU20215010	Protector Unit, ICP-F50
Q803	1	1	1	1	1	HC10056060	IC μ PC7805H
Q805	1	1	1	1	1	HT315682A0	Transistor 2SC1568
Δ Q806	1	1	1	1	1	FU20215010	Protector Unit, ICP-F50
Δ Q807	1	1	1	1	1	FU20215010	Protector Unit, ICP-F50
Q808	1	1	1	1	1	FU60115010	Protector Unit, ICP-F15
Q809	1	1	1	1	1	FU60115010	Protector Unit, ICP-F15
Q810	1	1	1	1	1	HC10043060	IC μ PC7812H
Q811	1	1	1	1	1	HC10044060	IC μ PC7912H
Q812	1	1	1	1	1	HT206321F0	Transistor 2SB632K(F)
Δ Q813	1	1	1	1	1	FU40115010	Protector Unit, ICP-F10
Q815	1	1	1	1	1	HT107332A0	Transistor 2SA733(P, Q)
QM02	1	1	1	1	1	HC10148030	IC LB1645N
P800-MISCELLANEOUS							
J801	1	1	1	1	1	YP06001060	Plug, 7P
J802	1	1	1	1	1	YJ06003060	Jack, 6P
J803	1	1	1	1	1	YJ06003070	Jack, 7P
J804	1	1	1	1	1	YJ06003050	Jack, 5P
J805	1	1	1	1	1	YP06001040	Plug, 3P
JM06	1	1	1	1	1	YJ06003060	Jack, 6P
JM07	1	1	1	1	1	YJ06003060	Jack, 6P
SM01	1	1	1	1	1	SP01010800	Push Switch, Tray Open/Close
PH00-FILTER CIRCUIT BOARD							
PH00	1	1	1	1	1	WB106K1860	P.W. Board, Filter
	1	1	1	1	1	ZZ106K8860	P.W. Board Assembly
PH00-CAPACITORS							
Δ CH01	1	1	1	1	1	DF77154810	Film 0.15 μ F $\pm 20\%$ 250V
Δ CH02	1	1	1	1	1	DF77154810	Film 0.15 μ F $\pm 20\%$ 250V
Δ CH03	1	1	1	1	1	DK16471800	Ceramic 470pF $\pm 10\%$ 400V
Δ CH04	1	1	1	1	1	DK16471800	Ceramic 470pF $\pm 10\%$ 400V
PH00-RESISTOR							
Δ RH01	1	1	1	1	1	RC05224120	220K Ω $\pm 5\%$ 1/8W
PH00-MISCELLANEOUS							
Δ LH01	1	1	1	1	1	TZ11560010	Choke Trans, 15mH x 2

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
PS10-POWER SWITCH CIRCUIT BOARD							
PS10	1	1	1	1	1	WB106K1870	P.W. Board, Power Switch
	1	1	1	1	1	ZZ106K1870	P.W. Board Assembly
Δ G801	1	1	1	1	1	DK18103840	Ceramic Cap. 0.01 μ F
Δ G801					1	DF16104510	Film Cap. 0.1 μ F $\pm 10\%$
Δ S801	1	1	1	1	1	SP01010650	Push Switch, Power
PS20-TEN KEY CIRCUIT BOARD							
PS20	1	1	1	1	1	WB106K2420	P.W. Board, Ten Key
	1	1	1	1	1	ZZ106K2420	P.W. Board Assembly
SS01	?	16	16	16	16	SP01010800	Push Switch, Tack
SS16							
PT10-FEATER U-CON CIRCUIT BOARD							
PT10	1	1	1	1	1	WB106K1840	P.W. Board, Feater U-Con
	1	1	1	1	1	ZZ106K1840	P.W. Board Assembly
PT10-CAPACITORS							
CT01	1	1	1	1	1	DK46223300	Ceramic 0.022 μ F $\pm 10\%$
CT02	1	1	1	1	1	OA10505010	Elect 1 μ F 50V
CT04	1	1	1	1	1	DK46103300	Ceramic 0.01 μ F $\pm 10\%$
CT05	1	1	1	1	1	OA10505010	Elect 1 μ F 50V
CT11	1	1	1	1	1	OA10605010	Elect 10 μ F 50V
CT12	1	1	1	1	1	OA10602510	Elect 10 μ F 25V
CT13	1	1	1	1	1	OA22703510	Elect 220 μ F 35V
PT10-RESISTORS (All Resistors are $\pm 5\%$ & 1/4W)							
RT01	1	1	1	1	1	WB05472020	4.7K Ω x 6, Composite
RT02	1	1	1	1	1	GD05473140	47K Ω
RT03	1	1	1	1	1	RI05333180	33K Ω 1/8W,Chip
RT04	1	1	1	1	1	GD05223140	22K Ω
RT05	1	1	1	1	1	GD05102140	1K Ω
RT06	1	1	1	1	1	BW05472010	4.7K Ω x 4, Composite
RT07	1	1	1	1	1	GD05154140	150K Ω
RT08	1	1	1	1	1	RI05472180	4.7K Ω 1/8W, Chip
RT09	1	1	1	1	1	RI05472180	4.7K Ω 1/8W, Chip
RT11	1	1	1	1	1	GD05152140	1.5K Ω
RT12	1	1	1	1	1	GD05471140	470 Ω
RT10-SEMICONDUCTORS							
DT01	1	1	1	1	1	HD20001000	Diode 1S1555
DT02	1	1	1	1	1	HD20022030	Diode DSF10C
DT03	1	1	1	1	1	HD20022030	Diode DSF10C
DT04	1	1	1	1	1	HD30043060	Zener RD8.2E
DT05	1	1	1	1	1	HD30022060	Zener RD22E
DT07	1	1	1	1	1	HD20001000	Diode 1S1555
QT01	1	1	1	1	1	HC10104060	IC μ PD1512ACU
QT02	1	1	1	1	1	HT313842A0	Transistor 2SC1384

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
PT10-MISCELLANEOUS							
JT01	1	1	1	1	1	YJ06003070	Jack, 7P
JT02	1	1	1	1	1	YJ06003160	Jack, 13P
JT03	1	1	1	1	1	YJ06003080	Jack, 8P
JT04	1	1	1	1	1	YJ06003080	Jack, 8P
JT06	1	1	1	1	1	YJ06002390	Jack, 5P
JT07	1	1	1	1	1	YJ06001980	Jack, 2P
JT09	1	1	1	1	1	YJ06001060	Jack, 7P
JT10	1	1	1	1	1	YJ06001040	Jack, 3P
LT01	1	1	1	1	1	LC14730040	Choke Coil, 47 μ H
PU10-HEADPHONE CIRCUIT BOARD							
PU10	1	1	1	1	1	WB106K1880	P.W. Board, Headphone
	1	1	1	1	1	ZZ106K1880	P.W. Board Assembly
PJ21	1	1	1	1	1	YJ01001790	Jack, Headphone
PJ21					1	YJ01002080	Jack, Headphone
PW10-RCA OUTPUT VR. CIRCUIT BOARD							
PW10	1	1	1	1	1	WB106K1850	P.W. Board, RCA Output VR.
	1					ZZ106K1850	P.W. Board Assembly
		1	1	1		ZZ106K8850	P.W. Board Assembly
PW10-RESISTORS							
RW01	1	1	1	1		RB02220010	2K Ω , Variable
RW02	1	1	1	1		RB02220010	2K Ω , Variable
RW03	1	1	1	1	1	RI05221180	220 Ω \pm 5% 1/8W,Chip
RW05	1	1	1	1	1	RI05473180	47K Ω \pm 5% 1/8W,Chip
RW07	1	1	1	1	1	RI05472180	4.7K Ω \pm 5% 1/8W,Chip
PW10-SEMICONDUCTORS							
DW01	1	1	1	1	1	HD30035060	Zener RD6.3E
QW01	1	1	1	1	1	BA20001020	Semicon Composite, UN2215
QW02	1	1	1	1	1	BA10001020	Semicon Composite, UN2214
QW03	1	1	1	1	1	BA20001020	Semicon Composite, UN2215
PW10-MISCELLANEOUS							
WT01	1	1	1	1	1	YT02020440	Terminal, 2P; RCA Jack
WT02	1	1	1	1	1	YT02020330	Terminal, 2P; RCA Jack
WT03	1	1	1	1	1	YT02020420	Terminal, 2P; RCA Jack
WT03	1	1	1	1	1	YT02020330	Terminal, 2P; RCA Jack
PX20-IN/OUT CIRCUIT BOARD							
PX20	1	1	1	1	1	WB106K2440	P.W. Board, IN/OUT
	1	1	1	1	1	ZZ106K2440	P.W. Board Assembly
SX01	1	1	1	1	1	SP01010800	Push Switch, Tack
PY20-DISPLAY CIRCUIT BOARD							
PY20	1	1	1	1	1	WB106K2410	P.W. Board, Display
	1	1	1	1	1	ZZ106K2410	P.W. Board Assembly
PY20-CAPACITORS							
CY01	1	1	1	1	1	OA10505010	Elect 1 μ F 50V
CY02	1	1	1	1	1	DK46223300	Ceramic 0.022 μ F \pm 10%

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
PY20-RESISTORS (All Resistors are \pm 5% & 1/8W)							
RY01	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY02	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY03	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY04	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY05	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY06	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY07	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY08	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY09	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY10	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY13	1	1	1	1	1	RI05472180	4.7K Ω , Chip
RY14	1	1	1	1	1	RI05473180	47K Ω , Chip
RY15	1	1	1	1	1	RI05103180	10K Ω , Chip
RY16	1	1	1	1	1	RI05103180	10K Ω , Chip
RY17	1	1	1	1	1	RI05102180	1K Ω , Chip
RY18	1	1	1	1	1	RI05102180	1K Ω , Chip
RY19	1	1	1	1	1	RI05222180	2.2K Ω , Chip
RY20	1	1	1	1	1	RI05222180	2.2K Ω , Chip
RY21	1	1	1	1	1	BW05154010	150K Ω x 8, Composite
RY22	1	1	1	1	1	BW05154010	150K Ω x 8, Composite
RY23	1	1	1	1	1	BW05154020	150K Ω x 10, Composite
RY30	1	1	1	1	1	GD05392140	3.9K Ω 1/4W
PY20-SEMICONDUCTORS							
DY01	1	1	1	1	1	HD20001000	Diode 1S1555
QY01	1	1	1	1	1	HC10106060	IC μ PD1510AC
QY02	1	1	1	1	1	HC10104260	IC MSL918RS
QY03	1	1	1	1	1	HC10104260	IC MSL918RS
QY04	1	1	1	1	1	HC10104260	IC MSL918RS
QY05	1	1	1	1	1	HT327852A0	Transistor 2SC2785(RF,JF)
QY06	1	1	1	1	1	HT327852A0	Transistor 2SC2785(RF,JF)
QY07	1	1	1	1	1	HT111752A0	Transistor 2SA1175(RF,JF)
QY08	1	1	1	1	1	HT111752A0	Transistor 2SA1175(RF,JF)
PY20-MISCELLANEOUS							
JY03	1	1	1	1	1	YP06002540	Plug, 4P
SY01	}	12	12	12	12	SP01010800	Push Switch, Tact
SY12							
VY01	1	1	1	1	1	HQ30801060	Display Unit
PZ20-SENSOR CIRCUIT BOARD							
PZ20	1	1	1	1	1	WB106K2430	P.W. Board, Sensor
	1	1	1	1	1	ZZ106K2430	P.W. Board Assembly
PZ20-CAPACITORS							
CZ01	1	1	1	1	1	DK46333300	Ceramic 0.033 μ F \pm 10%,Chip
CZ02	1	1	1	1	1	DK46472300	Ceramic 4700pF \pm 10%,Chip
CZ03	1	1	1	1	1	EJ10601610	Elect 10 μ F 16V
CZ04	1	1	1	1	1	EJ47502510	Elect 4.7 μ F 25V
CZ05	1	1	1	1	1	EJ10601610	Elect 10 μ F 16V
CZ06	1	1	1	1	1	EJ47601610	Elect 47 μ F 16V

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
							PZ20-RESISTORS
RZ01	1	1	1	1	1	RI05224180	220K Ω \pm 5% 1/8W,Chip
RZ02	1	1	1	1	1	RI05120180	12 Ω \pm 5% 1/8W,Chip
RZ03	1	1	1	1	1	RI05102180	1K Ω \pm 5% 1/8W,Chip
							PZ20-SEMICONDUCTORS
DZ01	1	1	1	1	1	HI60001060	L.E.D. PH302
QZ01	1	1	1	1	1	HC10071060	IC μ PC1373H
							PZ20-MISCELLANEOUS
LZ01	1	1	1	1	1	LA74020010	Antenna Coil, 5mH
							PT51-CARBON CONTACT CIRCUIT BOARD
PT51		1	1	1	1	YF113K1210	P.W. Board, Carbon Contact
		1	1	1	1	ZZ113K1210	P.W. Board Assembly
							PT51-CAPACITORS
CT51		1	1	1	1	DK16121300	Ceramic 120pF \pm 10%
CT52		1	1	1	1	DK16471300	Ceramic 470pF \pm 10%
CT53		1	1	1	1	OA47405010	Elect 0.47 μ F 50V
							PT51-RESISTORS
RT51		1	1	1	1	GD05102140	1K Ω \pm 5% $\frac{1}{4}$ W
RT52		1	1	1	1	GD05022140	2.2 Ω \pm 5% $\frac{1}{4}$ W

REF. DESIG.	Q'TY					PART NO.	DESCRIPTION
	U	N	A	P	F		
							PT51-SEMICONDUCTORS
QT51		1	1	1	1	HI10030020	L.E.D. LN224RP
QT52		1	1	1	1	HI20003320	L.E.D. GL-521
QT53		1	1	1	1	HI20003320	L.E.D. GL-521
QT54		1	1	1	1	HT320011K0	Transistor Diode Drive
QT55		1	1	1	1	HC10070060	IC μ PD6102G
DT51		1	1	1	1	HD20001210	Diode 1S2473
DT52		1	1	1	1	HD20001210	Diode 1S2473
DT53		1	1	1	1	HD20001210	Diode 1S2473
DT54		1	1	1	1	HD20001210	Diode 1S2473
DT55		1	1	1	1	HD20001210	Diode 1S2473
							PT51-MISCELLANEOUS
FT51		1	1	1	1	FQ04003020	Seramic Vibrator, 400kHz
							PT52-SWITCH CIRCUIT BOARD
PT52		1	1	1	1	YF113K1220	P.W. Board, Switch
		1	1	1	1	ZZ113K1220	P.W. Board Assembly
ST51		1	1	1	1	SS01020510	Slide Switch, ON/OFF

(W01-99)	Assembly and Wiring
(T01-99)	Adjustment
(X01-00)	Correction

NOTE ON SAFETY:
 SYMBOL \triangle FIRE OR ELECTRICAL SHOCK HAZARD. ONLY ORIGINAL PARTS SHOULD BE USED TO REPLACE ANY PART MARKED WITH SYMBOL \triangle . ANY OTHER COMPONENT SUBSTITUTION (OTHER THAN ORIGINAL TYPE) MAY INCREASE RISK OF FIRE OR ELECTRICAL SHOCK HAZARD.

18. SPECIFICATIONS

AUDIO PERFORMANCE

Number of Channels	2
Frequency Range	4 – 20,000 Hz
Dynamic Range	> 90 dB
Signal-to-Noise Ratio	> 90 dB
Total Harmonic Distortion (incl. noise)	< 0.003 %
Wow and Flutter	quartz crystal precision
D/A Conversion	16 bit with digital filtering
Error Correction System	Cross Interleave Reed Solomon Code (CIRC)
Audio Output Level	2 V rms

OPTICAL READOUT SYSTEM

Laser	semi-conductor AlGaAs
Wave length	0.78 μ m

SIGNAL FORMAT

Sampling Frequency	44.1 kHz
Quantization	16 bit linear/channel

DISC

Diameter	120 mm
Thickness	1.2 mm
Sense of rotation (seen from reading side)	anti-clockwise
Scanning Velocity	1.2 – 1.4 m/s
Rotation Speed	500 – 200 rpm
Playing Time (max)	60 min (stereo)
Track Pitch	1.6 μ m
Material	plastic

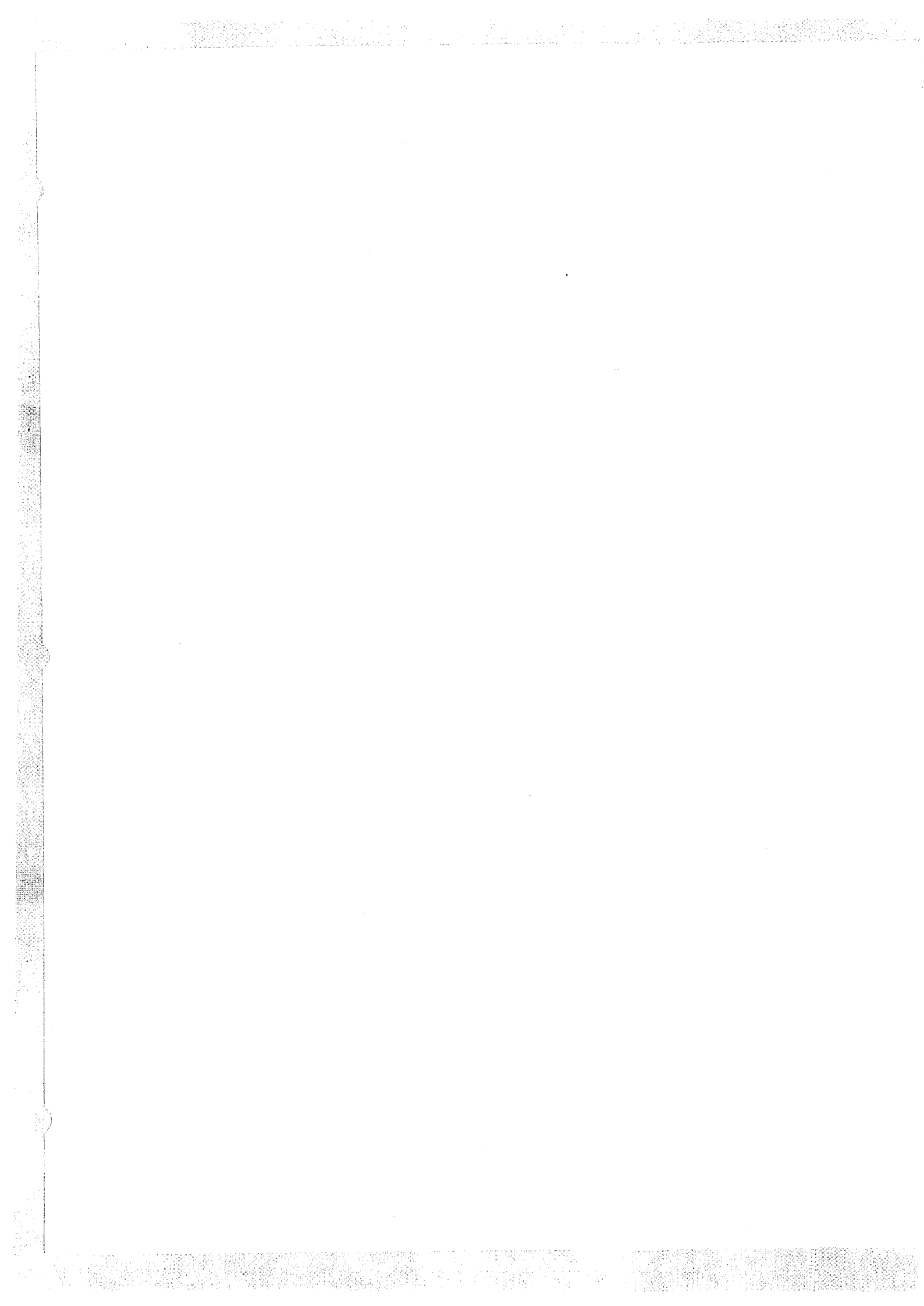
POWER SUPPLY

Mains Voltage	see type plate at the rear panel of the player
Material/finish	polystyrene with extruded aluminium profiles
This model is convertible to 110/120/220/240 volts by changing voltage selector on the rear panel.	
Mains Frequencies	50 and 60 Hz
Power Consumption	32 W approx
Safety Requirements	IEC

CABINET, GENERAL

Dimensions (W × H × D)	
with drawer closed	416 × 90 × 300 mm
with drawer open	416 × 90 × 440 mm
Weight	9.2 kg approx
Connection Cable	fitted with moulded RCA plugs

Specifications and appearance are subject to change modification without notice.





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